Features

- High Performance, Low Power 32-Bit Atmel[®] AVR[®] Microcontroller
 - Compact Single-cycle RISC Instruction Set Including DSP Instruction Set
 - Read-Modify-Write Instructions and Atomic Bit Manipulation
 - Performing 1.49 DMIPS / MHz
 - Up to 91 DMIPS Running at 66 MHz from Flash (1 Wait-State)
 - Up to 49 DMIPS Running at 33MHz from Flash (0 Wait-State)
 - Memory Protection Unit
- Multi-hierarchy Bus System
 - High-Performance Data Transfers on Separate Buses for Increased Performance
 - 15 Peripheral DMA Channels Improves Speed for Peripheral Communication
- Internal High-Speed Flash
 - 512K Bytes, 256K Bytes, 128K Bytes Versions
 - Single Cycle Access up to 33 MHz
 - Prefetch Buffer Optimizing Instruction Execution at Maximum Speed
 - 4ms Page Programming Time and 8ms Full-Chip Erase Time
 - 100,000 Write Cycles, 15-year Data Retention Capability
 - Flash Security Locks and User Defined Configuration Area
- Internal High-Speed SRAM, Single-Cycle Access at Full Speed
- 64K Bytes (512KB and 256KB Flash), 32K Bytes (128KB Flash)
- External Memory Interface on AT32UC3A0 Derivatives
 - SDRAM / SRAM Compatible Memory Bus (16-bit Data and 24-bit Address Buses)
- Interrupt Controller
- Autovectored Low Latency Interrupt Service with Programmable Priority
- System Functions
 - Power and Clock Manager Including Internal RC Clock and One 32KHz Oscillator
 - Two Multipurpose Oscillators and Two Phase-Lock-Loop (PLL) allowing Independent CPU Frequency from USB Frequency
 - Watchdog Timer, Real-Time Clock Timer
- Universal Serial Bus (USB)
 - Device 2.0 Full Speed and On-The-Go (OTG) Low Speed and Full Speed
 - Flexible End-Point Configuration and Management with Dedicated DMA Channels
 - On-chip Transceivers Including Pull-Ups
- Ethernet MAC 10/100 Mbps interface
 - 802.3 Ethernet Media Access Controller
 - Supports Media Independent Interface (MII) and Reduced MII (RMII)
- One Three-Channel 16-bit Timer/Counter (TC)
- Three External Clock Inputs, PWM, Capture and Various Counting Capabilities
- One 7-Channel 16-bit Pulse Width Modulation Controller (PWM)
- Four Universal Synchronous/Asynchronous Receiver/Transmitters (USART)
 - Independant Baudrate Generator, Support for SPI, IrDA and ISO7816 interfaces
 - Support for Hardware Handshaking, RS485 Interfaces and Modem Line
- Two Master/Slave Serial Peripheral Interfaces (SPI) with Chip Select Signals
- One Synchronous Serial Protocol Controller
 - Supports I2S and Generic Frame-Based Protocols
- One Master/Slave Two-Wire Interface (TWI), 400kbit/s I2C-compatible
- One 8-channel 10-bit Analog-To-Digital Converter
- 16-bit Stereo Audio Bitstream
 - Sample Rate Up to 50 KHz





32-Bit Atmel AVR Microcontroller

AT32UC3A0512 AT32UC3A0256 AT32UC3A0128 AT32UC3A1512 AT32UC3A1256 AT32UC3A1128

Summary

32058KS-AVR32-01/12

AT32UC3A

- On-Chip Debug System (JTAG interface)
 - Nexus Class 2+, Runtime Control, Non-Intrusive Data and Program Trace
- 100-pin TQFP (69 GPIO pins), 144-pin LQFP (109 GPIO pins) , 144 BGA (109 GPIO pins)
- 5V Input Tolerant I/Os
- Single 3.3V Power Supply or Dual 1.8V-3.3V Power Supply



1. Description

The AT32UC3A is a complete System-On-Chip microcontroller based on the AVR32 UC RISC processor running at frequencies up to 66 MHz. AVR32 UC is a high-performance 32-bit RISC microprocessor core, designed for cost-sensitive embedded applications, with particular emphasis on low power consumption, high code density and high performance.

The processor implements a Memory Protection Unit (MPU) and a fast and flexible interrupt controller for supporting modern operating systems and real-time operating systems. Higher computation capabilities are achievable using a rich set of DSP instructions.

The AT32UC3A incorporates on-chip Flash and SRAM memories for secure and fast access. For applications requiring additional memory, an external memory interface is provided on AT32UC3A0 derivatives.

The Peripheral Direct Memory Access controller (PDCA) enables data transfers between peripherals and memories without processor involvement. PDCA drastically reduces processing overhead when transferring continuous and large data streams between modules within the MCU.

The PowerManager improves design flexibility and security: the on-chip Brown-Out Detector monitors the power supply, the CPU runs from the on-chip RC oscillator or from one of external oscillator sources, a Real-Time Clock and its associated timer keeps track of the time.

The Timer/Counter includes three identical 16-bit timer/counter channels. Each channel can be independently programmed to perform frequency measurement, event counting, interval measurement, pulse generation, delay timing and pulse width modulation.

The PWM modules provides seven independent channels with many configuration options including polarity, edge alignment and waveform non overlap control. One PWM channel can trigger ADC conversions for more accurate close loop control implementations.

The AT32UC3A also features many communication interfaces for communication intensive applications. In addition to standard serial interfaces like UART, SPI or TWI, other interfaces like flexible Synchronous Serial Controller, USB and Ethernet MAC are available.

The Synchronous Serial Controller provides easy access to serial communication protocols and audio standards like I2S.

The Full-Speed USB 2.0 Device interface supports several USB Classes at the same time thanks to the rich End-Point configuration. The On-The-GO (OTG) Host interface allows device like a USB Flash disk or a USB printer to be directly connected to the processor.

The media-independent interface (MII) and reduced MII (RMII) 10/100 Ethernet MAC module provides on-chip solutions for network-connected devices.

AT32UC3A integrates a class 2+ Nexus 2.0 On-Chip Debug (OCD) System, with non-intrusive real-time trace, full-speed read/write memory access in addition to basic runtime control.



2. Configuration Summary

Device	Flash	SRAM	Ext. Bus Interface	Ethernet MAC	Package
AT32UC3A0512	512 Kbytes	64 Kbytes	yes	yes	144 pin LQFP 144 pin BGA
AT32UC3A0256	256 Kbytes	64 Kbytes	yes	yes	144 pin LQFP 144 pin BGA
AT32UC3A0128	128 Kbytes	32 Kbytes	yes	yes	144 pin LQFP 144 pin BGA
AT32UC3A1512	512 Kbytes	64 Kbytes	no	yes	100 pin TQFP
AT32UC3A1256	256 Kbytes	64 Kbytes	no	yes	100 pin TQFP
AT32UC3A1128	128 Kbytes	32 Kbytes	no	yes	100 pin TQFP

The table below lists all AT32UC3A memory and package configurations:

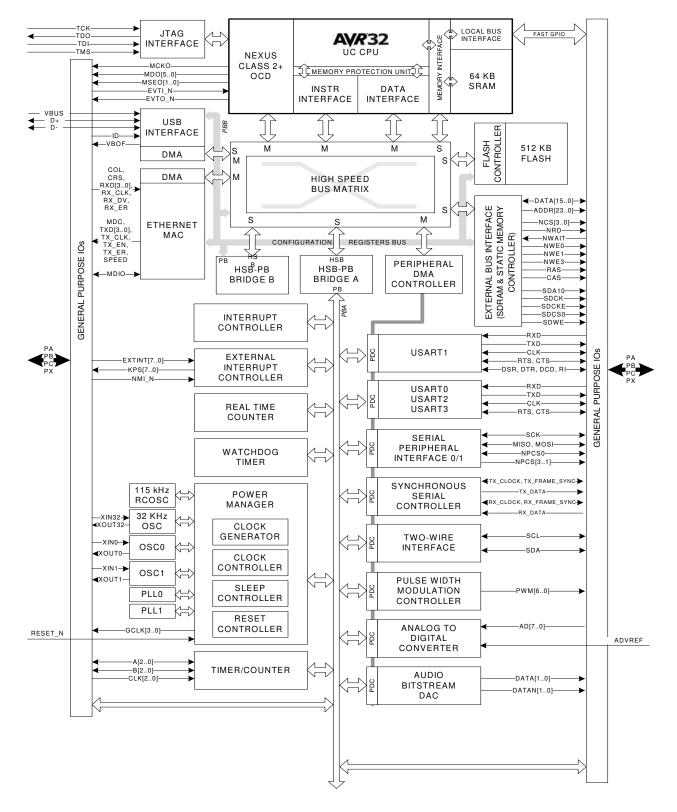
3. Abbreviations

- GCLK: Power Manager Generic Clock
- GPIO: General Purpose Input/Output
- HSB: High Speed Bus
- MPU: Memory Protection Unit
- OCD: On Chip Debug
- PB: Peripheral Bus
- PDCA: Peripheral Direct Memory Access Controller (PDC) version A
- USBB: USB On-The-GO Controller version B



4. Blockdiagram

Figure 4-1. Blockdiagram





4.1 Processor and architecture

4.1.1 AVR32 UC CPU

- 32-bit load/store AVR32A RISC architecture.
 - 15 general-purpose 32-bit registers.
 - 32-bit Stack Pointer, Program Counter and Link Register reside in register file.
 - Fully orthogonal instruction set.
 - Privileged and unprivileged modes enabling efficient and secure Operating Systems.
 - Innovative instruction set together with variable instruction length ensuring industry leading code density.
 - DSP extention with saturating arithmetic, and a wide variety of multiply instructions.
- 3 stage pipeline allows one instruction per clock cycle for most instructions.
 - Byte, half-word, word and double word memory access.
 - Multiple interrupt priority levels.
- MPU allows for operating systems with memory protection.

4.1.2 Debug and Test system

- IEEE1149.1 compliant JTAG and boundary scan
- Direct memory access and programming capabilities through JTAG interface
- Extensive On-Chip Debug features in compliance with IEEE-ISTO 5001-2003 (Nexus 2.0) Class 2+ - Low-cost NanoTrace supported.
- Auxiliary port for high-speed trace information
- Hardware support for 6 Program and 2 data breakpoints
- Unlimited number of software breakpoints supported
- Advanced Program, Data, Ownership, and Watchpoint trace supported

4.1.3 Peripheral DMA Controller

- Transfers from/to peripheral to/from any memory space without intervention of the processor.
- Next Pointer Support, forbids strong real-time constraints on buffer management.
- Fifteen channels
 - Two for each USART
 - Two for each Serial Synchronous Controller
 - Two for each Serial Peripheral Interface
 - One for each ADC
 - Two for each TWI Interface

4.1.4 Bus system

- High Speed Bus (HSB) matrix with 6 Masters and 6 Slaves handled
 - Handles Requests from the CPU Data Fetch, CPU Instruction Fetch, PDCA, USBB, Ethernet Controller, CPU SAB, and to internal Flash, internal SRAM, Peripheral Bus A, Peripheral Bus B, EBI.
 - Round-Robin Arbitration (three modes supported: no default master, last accessed default master, fixed default master)
 - Burst Breaking with Slot Cycle Limit
 - One Address Decoder Provided per Master



Peripheral Bus A able to run on at divided bus speeds compared to the High Speed Bus

Figure 4-1 gives an overview of the bus system. All modules connected to the same bus use the same clock, but the clock to each module can be individually shut off by the Power Manager. The figure identifies the number of master and slave interfaces of each module connected to the High Speed Bus, and which DMA controller is connected to which peripheral.



5. Signals Description

The following table gives details on the signal name classified by peripheral

The signals are multiplexed with GPIO pins as described in "Peripheral Multiplexing on I/O lines" on page 31.

Table 5-1.	Signal Description List
------------	-------------------------

Signal Name	Function	Туре	Active Level	Comments
	Po	wer		·
VDDPLL	Power supply for PLL	Power Input		1.65V to 1.95 V
VDDCORE	Core Power Supply	Power Input		1.65V to 1.95 V
VDDIO	I/O Power Supply	Power Input		3.0V to 3.6V
VDDANA	Analog Power Supply	Power Input		3.0V to 3.6V
VDDIN	Voltage Regulator Input Supply	Power Input		3.0V to 3.6V
VDDOUT	Voltage Regulator Output	Power Output		1.65V to 1.95 V
GNDANA	Analog Ground	Ground		
GND	Ground	Ground		
	Clocks, Oscilla	ators, and PLL's		
XIN0, XIN1, XIN32 Crystal 0, 1, 32 Input Analog				
XOUT0, XOUT1, XOUT32	Crystal 0, 1, 32 Output	Analog		
	J	AG		•
тск	Test Clock	Input		
TDI	Test Data In	Input		
TDO	Test Data Out	Output		
TMS	Test Mode Select	Input		
	Auxiliary	Port - AUX		
МСКО	Trace Data Output Clock	Output		
MDO0 - MDO5	Trace Data Output	Output		



Signal Name	Function	Туре	Active Level	Comments
MSEO0 - MSEO1	Trace Frame Control	Output		
EVTI_N	Event In	Output	Low	
EVTO_N	Event Out	Output	Low	
	Power Manage	er - PM		
GCLK0 - GCLK3	Generic Clock Pins	Output		
RESET_N	Reset Pin	Input	Low	
	Real Time Coun	ter - RTC		
RTC_CLOCK	RTC clock	Output		
	Watchdog Time	r - WDT		
WDTEXT	External Watchdog Pin	Output		
External Interrupt Controller - EIC				
EXTINT0 - EXTINT7	External Interrupt Pins	Input		
KPS0 - KPS7	Keypad Scan Pins	Output		
NMI_N	Non-Maskable Interrupt Pin	Input	Low	
	Ethernet MAC	МАСВ	·	·
COL	Collision Detect	Input		
CRS	Carrier Sense and Data Valid	Input		
MDC	Management Data Clock	Output		
MDIO	Management Data Input/Output	I/O		
RXD0 - RXD3	Receive Data	Input		
RX_CLK	Receive Clock	Input		
RX_DV	Receive Data Valid	Input		
RX_ER	Receive Coding Error	Input		
SPEED	Speed			
TXD0 - TXD3	Transmit Data	Output		
TX_CLK	Transmit Clock or Reference Clock	Output		
TX_EN	Transmit Enable	Output		
TX_ER	Transmit Coding Error	Output		



Signal Name	Function	Туре	Active Level	Comments		
	External Bus Interface - HEBI					
ADDR0 - ADDR23	Address Bus	Output				
CAS	Column Signal	Output	Low			
DATA0 - DATA15	Data Bus	I/O				
NCS0 - NCS3	Chip Select	Output	Low			
NRD	Read Signal	Output	Low			
NWAIT	External Wait Signal	Input	Low			
NWE0	Write Enable 0	Output	Low			
NWE1	Write Enable 1	Output	Low			
NWE3	Write Enable 3	Output	Low			
RAS	Row Signal	Output	Low			
SDA10	SDRAM Address 10 Line	Output				
SDCK	SDRAM Clock	Output				
SDCKE	SDRAM Clock Enable	Output				
SDCS0	SDRAM Chip Select	Output	Low			
SDWE	SDRAM Write Enable	Output	Low			
	General Purpose Input/Ou	tput 2 - GPIOA, GPI	OB, GPIOC			
P0 - P31	Parallel I/O Controller GPIOA	I/O				
P0 - P31	Parallel I/O Controller GPIOB	I/O				
P0 - P5	Parallel I/O Controller GPIOC	I/O				
P0 - P31	Parallel I/O Controller GPIOX	I/O				
	Serial Peripheral Interface - SPI0, SPI1					
MISO	Master In Slave Out	I/O				
MOSI	Master Out Slave In	I/O				
NPCS0 - NPCS3	SPI Peripheral Chip Select	I/O	Low			
SCK	Clock	Output				
	Synchronous Se	erial Controller - SS	С			
RX_CLOCK	SSC Receive Clock	I/O				



Signal Name	Function	Туре	Active Level	Comments
RX_DATA	SSC Receive Data	Input		
RX_FRAME_SYNC	SSC Receive Frame Sync	I/O		
TX_CLOCK	SSC Transmit Clock	I/O		
TX_DATA	SSC Transmit Data	Output		
TX_FRAME_SYNC	SSC Transmit Frame Sync	I/O		
	Timer/Counter -	TIMER		
A0	Channel 0 Line A	I/O		
A1	Channel 1 Line A	I/O		
A2	Channel 2 Line A	I/O		
В0	Channel 0 Line B	I/O		
B1	Channel 1 Line B	I/O		
B2	Channel 2 Line B	I/O		
CLK0	Channel 0 External Clock Input	Input		
CLK1	Channel 1 External Clock Input	Input		
CLK2	Channel 2 External Clock Input	Input		
	Two-wire Interfac	e - TWI		
SCL	Serial Clock	I/O		
SDA	Serial Data	I/O		
Universa	I Synchronous Asynchronous Receiver Transr	nitter - USA	RT0, USAR	T1, USART2, USART3
CLK	Clock	I/O		
CTS	Clear To Send	Input		
DCD	Data Carrier Detect			Only USART1
DSR	Data Set Ready			Only USART1
DTR	Data Terminal Ready			Only USART1
RI	Ring Indicator			Only USART1
RTS	Request To Send	Output		
RXD	Receive Data	Input		
TXD	Transmit Data	Output		



Signal Name	Function	Туре	Active Level	Comments
	Analog to Digital Conv	erter - ADC		
AD0 - AD7	Analog input pins	Analog input		
ADVREF	Analog positive reference voltage input	Analog input		2.6 to 3.6V
	Pulse Width Modulat	or - PWM		
PWM0 - PWM6	PWM Output Pins	Output		
	Universal Serial Bus Device - USB			
DDM	USB Device Port Data -	Analog		
DDP	USB Device Port Data +	Analog		
VBUS	USB VBUS Monitor and OTG Negociation	Analog Input		
USBID	ID Pin of the USB Bus	Input		
USB_VBOF	USB VBUS On/off: bus power control port	output		
	Audio Bitstream DAC (ABDAC)			
DATA0-DATA1	D/A Data out	Outpu		
DATANO-DATAN1	D/A Data inverted out	Outpu		



6. Package and Pinout

The device pins are multiplexed with peripheral functions as described in "Peripheral Multiplexing on I/O lines" on page 31.

Figure 6-1. TQFP100 Pinout

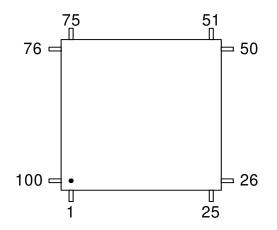


Table 6-1.TQFP100 Package Pinout

1	PB20
2	PB21
3	PB22
4	VDDIO
-	
5	GND
6	PB23
7	PB24
8	PB25
9	PB26
10	PB27
11	VDDOUT
12	VDDIN
13	GND
14	PB28
15	PB29
16	PB30
17	PB31
18	RESET_N
19	PA00
20	PA01
21	GND
22	VDDCORE

26	PA05
27	PA06
28	PA07
29	PA08
30	PA09
31	PA10
32	N/C
33	PA11
34	VDDCORE
35	GND
36	PA12
37	PA13
38	VDDCORE
39	PA14
40	PA15
41	PA16
42	PA17
43	PA18
44	PA19
45	PA20
46	VBUS
47	VDDIO

51	PA21
52	PA22
53	PA23
54	PA24
55	PA25
56	PA26
57	PA27
58	PA28
59	VDDANA
60	ADVREF
61	GNDANA
62	VDDPLL
63	PC00
64	PC01
65	PB00
66	PB01
67	VDDIO
68	VDDIO
69	GND
70	PB02
71	PB03
72	PB04

76	PB08
77	PB09
78	PB10
79	VDDIO
80	GND
81	PB11
82	PB12
83	PA29
84	PA30
85	PC02
86	PC03
87	PB13
88	PB14
89	TMS
90	ТСК
91	TDO
92	TDI
93	PC04
94	PC05
95	PB15
96	PB16
97	VDDCORE



Table 6-1.TQFP100 Package Pinout

23	PA02
24	PA03
25	PA04

48	DM
49	DP
50	GND

73	PB05
74	PB06
75	PB07

98	PB17
99	PB18
100	PB19

Figure 6-2. LQFP144 Pinout

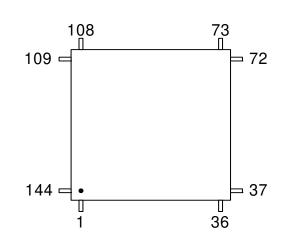


Table 6-2.VQFP144 Package Pinout

1	PX00
2	PX01
3	PB20
4	PX02
5	PB21
6	PB22
7	VDDIO
8	GND
9	PB23
10	PX03
11	PB24
12	PX04
13	PB25
14	PB26
15	PB27
16	VDDOUT
17	VDDIN
18	GND
19	PB28
20	PB29
21	PB30

e Fillout		
37	GND	
38	PX10	
39	PA05	
40	PX11	
41	PA06	
42	PX12	
43	PA07	
44	PX13	
45	PA08	
46	PX14	
47	PA09	
48	PA10	
49	N/C	
50	PA11	
51	VDDCORE	
52	GND	
53	PA12	
54	PA13	
55	VDDCORE	
56	PA14	
57	PA15	

73	PA21
74	PA22
75	PA23
76	PA24
77	PA25
78	PA26
79	PA27
80	PA28
81	VDDANA
82	ADVREF
83	GNDANA
84	VDDPLL
85	PC00
86	PC01
87	PX20
88	PB00
89	PX21
90	PB01
91	PX22
92	VDDIO
93	VDDIO

109 GND 110 PX30 111 PB08 112 PX31 113 PB09 114 PX32 115 PB10 116 VDDIO 117 GND 118 PX33 119 PB12 120 PX34 121 PB12 122 PA29 123 PA30 124 PC02 125 PC03 126 PB13 127 PB14 128 TMS 129 TCK		
111 PB08 112 PX31 113 PB09 114 PX32 115 PB10 116 VDDIO 117 GND 118 PX33 119 PB11 120 PX34 121 PB12 122 PA29 123 PA30 124 PC02 125 PC03 126 PB13 127 PB14 128 TMS	109	GND
112 PX31 113 PB09 114 PX32 115 PB10 116 VDDIO 117 GND 118 PX33 119 PB11 120 PX34 121 PB12 122 PA29 123 PA30 124 PC02 125 PC03 126 PB13 127 PB14 128 TMS	110	PX30
113 PB09 114 PX32 115 PB10 115 PB10 116 VDDIO 117 GND 118 PX33 119 PB11 120 PX34 121 PB12 122 PA29 123 PA30 124 PC02 125 PC03 126 PB13 127 PB14 128 TMS	111	PB08
114 PX32 115 PB10 116 VDDIO 117 GND 118 PX33 119 PB11 120 PX34 121 PB12 122 PA29 123 PA30 124 PC02 125 PC03 126 PB13 127 PB14 128 TMS	112	PX31
111 PB10 115 PB10 116 VDDIO 117 GND 118 PX33 119 PB11 120 PX34 121 PB12 122 PA29 123 PA30 124 PC02 125 PC03 126 PB13 127 PB14 128 TMS	113	PB09
116 VDDIO 117 GND 118 PX33 119 PB11 120 PX34 121 PB12 122 PA29 123 PA30 124 PC02 125 PC03 126 PB13 127 PB14 128 TMS	114	PX32
117 GND 118 PX33 119 PB11 120 PX34 121 PB12 122 PA29 123 PA30 124 PC02 125 PC03 126 PB13 127 PB14 128 TMS	115	PB10
118 PX33 119 PB11 120 PX34 121 PB12 122 PA29 123 PA30 124 PC02 125 PC03 126 PB14 127 PB14 128 TMS	116	VDDIO
119 PB11 120 PX34 121 PB12 122 PA29 123 PA30 124 PC02 125 PC03 126 PB13 127 PB14 128 TMS	117	GND
120 PX34 121 PB12 122 PA29 123 PA30 124 PC02 125 PC03 126 PB13 127 PB14 128 TMS	118	PX33
121 PB12 122 PA29 123 PA30 124 PC02 125 PC03 126 PB13 127 PB14 128 TMS	119	PB11
121 PA29 122 PA30 124 PC02 125 PC03 126 PB13 127 PB14 128 TMS	120	PX34
123 PA30 124 PC02 125 PC03 126 PB13 127 PB14 128 TMS	121	PB12
124 PC02 125 PC03 126 PB13 127 PB14 128 TMS	122	PA29
125 PC03 126 PB13 127 PB14 128 TMS	123	PA30
126 PB13 127 PB14 128 TMS	124	PC02
127 PB14 128 TMS	125	PC03
128 TMS	126	PB13
	127	PB14
129 TCK	128	TMS
	129	TCK



Table 6-2.VQFP144 Package Pinout

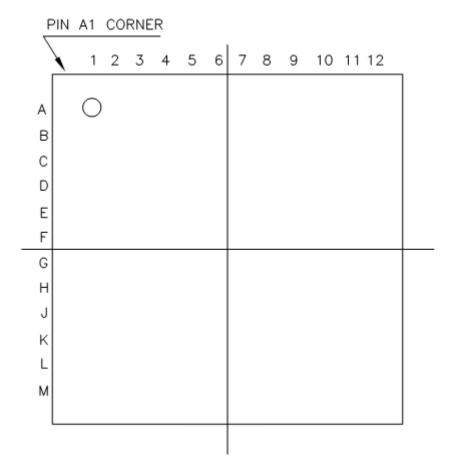
22	PB31
23	RESET_N
24	PX05
25	PA00
26	PX06
27	PA01
28	GND
29	VDDCORE
30	PA02
31	PX07
32	PA03
33	PX08
34	PA04
35	PX09
36	VDDIO

58	PA16	
59	PX15	
60	PA17	
61	PX16	
62	PA18	
63	PX17	
64	PA19	
65	PX18	
66	PA20	
67	PX19	
68	VBUS	
69	VDDIO	
70	DM	
71	DP	
72	GND	

94	GND
95	PX23
96	PB02
97	PX24
98	PB03
99	PX25
100	PB04
101	PX26
102	PB05
103	PX27
104	PB06
105	PX28
106	PB07
107	PX29
108	VDDIO

130	TDO
131	TDI
132	PC04
133	PC05
134	PB15
135	PX35
136	PB16
137	PX36
138	VDDCORE
139	PB17
140	PX37
141	PB18
142	PX38
143	PB19
144	PX39

Figure 6-3. BGA144 Pinout





	1	2	3	4	5	6	7	8
Α	VDDIO	PB07	PB05	PB02	PB03	PB01	PC00	PA28
В	PB08	GND	PB06	PB04	VDDIO	PB00	PC01	VDDPLL
С	PB09	PX33	PA29	PC02	PX28	PX26	PX22	PX21
D	PB11	PB13	PB12	PX30	PX29	PX25	PX24	PX20
Е	PB10	VDDIO	PX32	PX31	VDDIO	PX27	PX23	VDDANA
F	PA30	PB14	PX34	PB16	тск	GND	GND	PX16
G	TMS	PC03	PX36	PX35	PX37	GND	GND	PA16
н	TDO	VDDCORE	PX38	PX39	VDDIO	PA01	PA10	VDDCORE
J	TDI	PB17	PB15	PX00	PX01	PA00	PA03	PA04
κ	PC05	PC04	PB19	PB20	PX02	PB29	PB30	PA02
L	PB21	GND	PB18	PB24	VDDOUT	PX04	PB31	VDDIN
М	PB22	PB23	PB25	PB26	PX03	PB27	PB28	RESET_N

Table 6-4.BGA144 Package Pinout A9..M12

	9	10	11	12
Α	PA26	PA25	PA24	PA23
В	PA27	PA21	GND	PA22
С	ADVREF	GNDANA	PX19	PA19
D	PA18	PA20	DP	DM
Е	PX18	PX17	VDDIO	VBUS
F	PA17	PX15	PA15	PA14
G	PA13	PA12	PA11	NC
Н	PX11	PA08	VDDCORE	VDDCORE
J	PX14	PA07	PX13	PA09
к	PX08	GND	PA05	PX12
L	PX06	PX10	GND	PA06
М	PX05	PX07	PX09	VDDIO

Note: NC is not connected.



7. Power Considerations

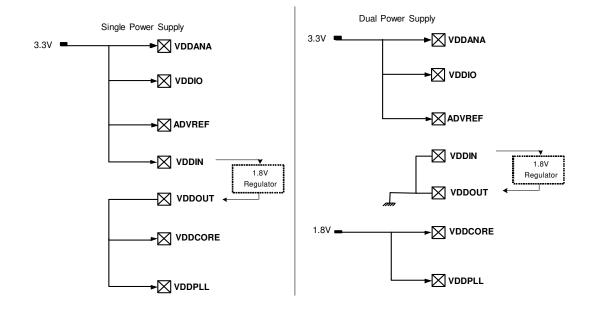
7.1 Power Supplies

The AT32UC3A has several types of power supply pins:

- VDDIO: Powers I/O lines. Voltage is 3.3V nominal.
- VDDANA: Powers the ADC Voltage is 3.3V nominal.
- VDDIN: Input voltage for the voltage regulator. Voltage is 3.3V nominal.
- VDDCORE: Powers the core, memories, and peripherals. Voltage is 1.8V nominal.
- VDDPLL: Powers the PLL. Voltage is 1.8V nominal.

The ground pins GND are common to VDDCORE, VDDIO, VDDPLL. The ground pin for VDDANA is GNDANA.

Refer to "Power Consumption" on page 44 for power consumption on the various supply pins.





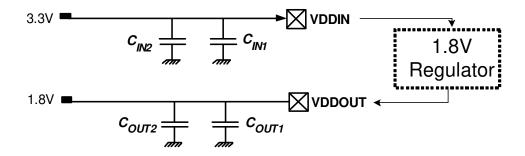
7.2 Voltage Regulator

7.2.1 Single Power Supply

The AT32UC3A embeds a voltage regulator that converts from 3.3V to 1.8V. The regulator takes its input voltage from VDDIN, and supplies the output voltage on VDDOUT. VDDOUT should be externally connected to the 1.8V domains.

Adequate input supply decoupling is mandatory for VDDIN in order to improve startup stability and reduce source voltage drop. Two input decoupling capacitors must be placed close to the chip.

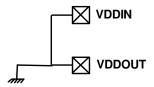
Adequate output supply decoupling is mandatory for VDDOUT to reduce ripple and avoid oscillations. The best way to achieve this is to use two capacitors in parallel between VDDOUT and GND as close to the chip as possible



Refer to Section 12.3 on page 42 for decoupling capacitors values and regulator characteristics

7.2.2 Dual Power Supply

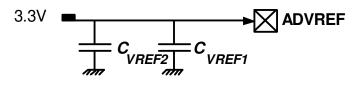
In case of dual power supply, VDDIN and VDDOUT should be connected to ground to prevent from leakage current.





7.3 Analog-to-Digital Converter (A.D.C) reference.

The ADC reference (ADVREF) must be provided from an external source. Two decoupling capacitors must be used to insure proper decoupling.



Refer to Section 12.4 on page 42 for decoupling capacitors values and electrical characteristics. In case ADC is not used, the ADVREF pin should be connected to GND to avoid extra consumption.



8. I/O Line Considerations

8.1 JTAG pins

TMS, TDI and TCK have pull-up resistors. TDO is an output, driven at up to VDDIO, and has no pull-up resistor.

8.2 RESET_N pin

The RESET_N pin is a schmitt input and integrates a permanent pull-up resistor to VDDIO. As the product integrates a power-on reset cell, the RESET_N pin can be left unconnected in case no reset from the system needs to be applied to the product.

8.3 TWI pins

When these pins are used for TWI, the pins are open-drain outputs with slew-rate limitation and inputs with inputs with spike-filtering. When used as GPIO-pins or used for other peripherals, the pins have the same characteristics as PIO pins.

8.4 GPIO pins

All the I/O lines integrate a programmable pull-up resistor. Programming of this pull-up resistor is performed independently for each I/O line through the GPIO Controllers. After reset, I/O lines default as inputs with pull-up resistors disabled, except when indicated otherwise in the column "Reset State" of the GPIO Controller multiplexing tables.



9. Memories

9.1 Embedded Memories

- Internal High-Speed Flash
 - 512 KBytes (AT32UC3A0512, AT32UC3A1512)
 - 256 KBytes (AT32UC3A0256, AT32UC3A1256)
 - 128 KBytes (AT32UC3A1128, AT32UC3A2128)
 - 0 Wait State Access at up to 33 MHz in Worst Case Conditions
 - 1 Wait State Access at up to 66 MHz in Worst Case Conditions
 - Pipelined Flash Architecture, allowing burst reads from sequential Flash locations, hiding penalty of 1 wait state access

- Pipelined Flash Architecture typically reduces the cycle penalty of 1 wait state operation to only 15% compared to 0 wait state operation

- 100 000 Write Cycles, 15-year Data Retention Capability
- 4 ms Page Programming Time, 8 ms Chip Erase Time
- Sector Lock Capabilities, Bootloader Protection, Security Bit
- 32 Fuses, Erased During Chip Erase
- User Page For Data To Be Preserved During Chip Erase
- Internal High-Speed SRAM, Single-cycle access at full speed
 - 64 KBytes (AT32UC3A0512, AT32UC3A0256, AT32UC3A1512, AT32UC3A1256)
 - 32KBytes (AT32UC3A1128)

9.2 Physical Memory Map

The system bus is implemented as a bus matrix. All system bus addresses are fixed, and they are never remapped in any way, not even in boot. Note that AVR32 UC CPU uses unsegmented translation, as described in the AVR32 Architecture Manual. The 32-bit physical address space is mapped as follows:

Device	Start Address	Size					
Device	Start Address	AT32UC3A0512	AT32UC3A1512	AT32UC3A0256	AT32UC3A1256	AT32UC3A0128	AT32UC3A1128
Embedded SRAM	0x0000_0000	64 Kbyte	64 Kbyte	64 Kbyte	64 Kbyte	32 Kbyte	32 Kbyte
Embedded Flash	0x8000_0000	512 Kbyte	512 Kbyte	256 Kbyte	256 Kbyte	128 Kbyte	128 Kbyte
EBI SRAM CS0	0xC000_0000	16 Mbyte	-	16 Mbyte	-	16 Mbyte	-
EBI SRAM CS2	0xC800_0000	16 Mbyte	-	16 Mbyte	-	16 Mbyte	-
EBI SRAM CS3	0xCC00_0000	16 Mbyte	-	16 Mbyte	-	16 Mbyte	-
EBI SRAM CS1 /SDRAM CS0	0xD000_0000	128 Mbyte	-	128 Mbyte	-	128 Mbyte	-
USB Configuration	0xE000_0000	64 Kbyte					
HSB-PB Bridge A	0xFFFE_0000	64 Kbyte					
HSB-PB Bridge B	0xFFFF_0000	64 Kbyte					

 Table 9-1.
 AT32UC3A Physical Memory Map



Part Number	Flash Size (<i>FLASH_PW</i>)	Number of pages (FLASH_P)	Page size (<i>FLASH_W</i>)	General Purpose Fuse bits (FLASH_F)
AT32UC3A0512	512 Kbytes	1024	128 words	32 fuses
AT32UC3A1512	512 Kbytes	1024	128 words	32 fuses
AT32UC3A0256	256 Kbytes	512	128 words	32 fuses
AT32UC3A1256	256 Kbytes	512	128 words	32 fuses
AT32UC3A1128	128 Kbytes	256	128 words	32 fuses
AT32UC3A0128	128 Kbytes	256	128 words	32 fuses

Table 9-2.Flash Memory Parameters

9.3 Bus Matrix Connections

Accesses to unused areas returns an error result to the master requesting such an access.

The bus matrix has the several masters and slaves. Each master has its own bus and its own decoder, thus allowing a different memory mapping per master. The master number in the table below can be used to index the HMATRIX control registers. For example, MCFG0 is associated with the CPU Data master interface.

Table 9-3.	Figh Speed bus masters		
Master 0	CPU Data		
Master 1	CPU Instruction		
Master 2	CPU SAB		
Master 3	PDCA		
Master 4	MACB DMA		
Master 5	USBB DMA		

Table 9-3.High Speed Bus masters

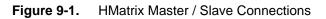
Each slave has its own arbiter, thus allowing a different arbitration per slave. The slave number in the table below can be used to index the HMATRIX control registers. For example, SCFG3 is associated with the Internal SRAM Slave Interface.

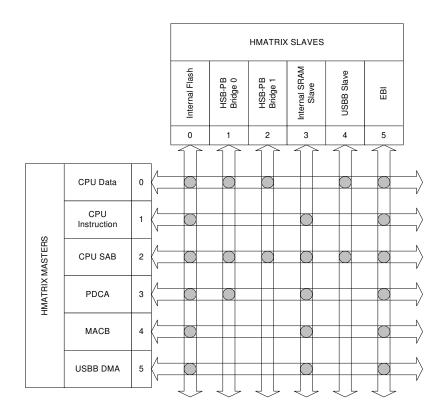
Table 9-4.	High Speed Bus slaves
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	•
Slave 0	Internal Flash
Slave 1	HSB-PB Bridge 0
Slave 2	HSB-PB Bridge 1
Slave 3	Internal SRAM
Slave 4	USBB DPRAM
Slave 5	EBI



AT32UC3A







10. Peripherals

10.1 Peripheral address map

 Table 10-1.
 Peripheral Address Mapping

Address		Peripheral Name	Bus
		1	
0xE0000000	USBB	USBB Slave Interface - USBB	HSB
0xFFFE0000	USBB	USBB Configuration Interface - USBB	PBB
0xFFFE1000	HMATRIX	HMATRIX Configuration Interface - HMATRIX	PBB
0xFFFE1400	FLASHC	Flash Controller - FLASHC	PBB
0xFFFE1800	MACB	MACB Configuration Interface - MACB	PBB
0xFFFE1C00	SMC	Static Memory Controller Configuration Interface -	PBB
0xFFFE2000	SDRAMC	SDRAM Controller Configuration Interface - SDRAMC	PBB
0xFFFF0000	PDCA	Peripheral DMA Interface - PDCA	PBA
0xFFFF0800	INTC	Interrupt Controller Interface - INTC	PBA
0xFFFF0C00	РМ	Power Manager - PM	PBA
0xFFFF0D00	RTC	Real Time Clock - RTC	PBA
0xFFFF0D30	WDT	WatchDog Timer - WDT	PBA
0xFFFF0D80	EIC	External Interrupt Controller - EIC	PBA
0xFFFF1000	GPIO	General Purpose IO Controller - GPIO	PBA
0xFFFF1400	USART0	Universal Synchronous Asynchronous Receiver Transmitter - USART0	PBA
0xFFFF1800	USART1	Universal Synchronous Asynchronous Receiver Transmitter - USART1	PBA
l		1	



Table 10-1. Peripheral Address Mapping (Continued)

Address		Peripheral Name	Bus
0xFFFF1C00	USART2	Universal Synchronous Asynchronous Receiver Transmitter - USART2	PBA
0xFFFF2000	USART3	Universal Synchronous Asynchronous Receiver Transmitter - USART3	PBA
0xFFFF2400	SPI0	Serial Peripheral Interface - SPI0	PBA
0xFFFF2800	SPI1	Serial Peripheral Interface - SPI1	PBA
0xFFFF2C00	TWI	Two Wire Interface - TWI	PBA
0xFFFF3000	PWM	Pulse Width Modulation Controller - PWM	PBA
0xFFFF3400	SSC	Synchronous Serial Controller - SSC	PBA
0xFFFF3800	тс	Timer/Counter - TC	PBA
0xFFFF3C00	ADC	Analog To Digital Converter - ADC	PBA

10.2 CPU Local Bus Mapping

Some of the registers in the GPIO module are mapped onto the CPU local bus, in addition to being mapped on the Peripheral Bus. These registers can therefore be reached both by accesses on the Peripheral Bus, and by accesses on the local bus.

Mapping these registers on the local bus allows cycle-deterministic toggling of GPIO pins since the CPU and GPIO are the only modules connected to this bus. Also, since the local bus runs at CPU speed, one write or read operation can be performed per clock cycle to the local busmapped GPIO registers.



The following GPIO registers are mapped on the local bus:

 Table 10-2.
 Local bus mapped GPIO registers

Port	Register	Mode	Local Bus Address	Access
0	Output Driver Enable Register (ODER)	WRITE	0x4000_0040	Write-only
		SET	0x4000_0044	Write-only
		CLEAR	0x4000_0048	Write-only
		TOGGLE	0x4000_004C	Write-only
	Output Value Register (OVR)	WRITE	0x4000_0050	Write-only
		SET	0x4000_0054	Write-only
		CLEAR	0x4000_0058	Write-only
		TOGGLE	0x4000_005C	Write-only
	Pin Value Register (PVR)	-	0x4000_0060	Read-only
1	Output Driver Enable Register (ODER)	WRITE	0x4000_0140	Write-only
		SET	0x4000_0144	Write-only
		CLEAR	0x4000_0148	Write-only
		TOGGLE	0x4000_014C	Write-only
	Output Value Register (OVR)	WRITE	0x4000_0150	Write-only
		SET	0x4000_0154	Write-only
		CLEAR	0x4000_0158	Write-only
		TOGGLE	0x4000_015C	Write-only
	Pin Value Register (PVR)	-	0x4000_0160	Read-only
2	Output Driver Enable Register (ODER)	WRITE	0x4000_0240	Write-only
		SET	0x4000_0244	Write-only
		CLEAR	0x4000_0248	Write-only
		TOGGLE	0x4000_024C	Write-only
	Output Value Register (OVR)	WRITE	0x4000_0250	Write-only
		SET	0x4000_0254	Write-only
		CLEAR	0x4000_0258	Write-only
		TOGGLE	0x4000_025C	Write-only
	Pin Value Register (PVR)	-	0x4000_0260	Read-only



Port	Register	Mode	Local Bus Address	Access
3	Output Driver Enable Register (ODER)	WRITE	0x4000_0340	Write-only
			0x4000_0344	Write-only
		CLEAR	0x4000_0348	Write-only
		TOGGLE	0x4000_034C	Write-only
Output Value Register (OVR)	WRITE	0x4000_0350	Write-only	
	SET	0x4000_0354	Write-only	
		CLEAR	0x4000_0358	Write-only
		TOGGLE	0x4000_035C	Write-only
	Pin Value Register (PVR)	-	0x4000_0360	Read-only

 Table 10-2.
 Local bus mapped GPIO registers

10.3 Interrupt Request Signal Map

The various modules may output Interrupt request signals. These signals are routed to the Interrupt Controller (INTC), described in a later chapter. The Interrupt Controller supports up to 64 groups of interrupt requests. Each group can have up to 32 interrupt request signals. All interrupt signals in the same group share the same autovector address and priority level. Refer to the documentation for the individual submodules for a description of the semantics of the different interrupt requests.

The interrupt request signals are connected to the INTC as follows.

Group	Line	Module	Signal
0	0	AVR32 UC CPU with optional MPU and optional OCD	SYSBLOCK COMPARE
	0	External Interrupt Controller	EIC 0
	1	External Interrupt Controller	EIC 1
	2	External Interrupt Controller	EIC 2
	3	External Interrupt Controller	EIC 3
	4	External Interrupt Controller	EIC 4
1	5	External Interrupt Controller	EIC 5
6		External Interrupt Controller	EIC 6
	7	External Interrupt Controller	EIC 7
	8	Real Time Counter	RTC
	9	Power Manager	PM
	10	Frequency Meter	FREQM

 Table 10-3.
 Interrupt Request Signal Map



Table 10-3.	Interrupt Request Signal Map							
	0	General Purpose Input/Output	GPIO 0					
	1	General Purpose Input/Output	GPIO 1					
	2	General Purpose Input/Output	GPIO 2					
	3	General Purpose Input/Output	GPIO 3					
	4	General Purpose Input/Output	GPIO 4					
	5	General Purpose Input/Output	GPIO 5					
<u> </u>	6	General Purpose Input/Output	GPIO 6					
2	7	General Purpose Input/Output	GPIO 7					
	8	General Purpose Input/Output	GPIO 8					
	9	General Purpose Input/Output	GPIO 9					
	10	General Purpose Input/Output	GPIO 10					
	11	General Purpose Input/Output	GPIO 11					
	12	General Purpose Input/Output	GPIO 12					
	13	General Purpose Input/Output	GPIO 13					
	0	Peripheral DMA Controller	PDCA 0					
	1	Peripheral DMA Controller	PDCA 1					
	2	Peripheral DMA Controller	PDCA 2					
	3	Peripheral DMA Controller	PDCA 3					
	4	Peripheral DMA Controller	PDCA 4					
	5	Peripheral DMA Controller	PDCA 5					
	6	Peripheral DMA Controller	PDCA 6					
3	7	Peripheral DMA Controller	PDCA 7					
	8	Peripheral DMA Controller	PDCA 8					
	9	Peripheral DMA Controller	PDCA 9					
	10	Peripheral DMA Controller	PDCA 10					
	11	Peripheral DMA Controller	PDCA 11					
	12	Peripheral DMA Controller	PDCA 12					
	13	Peripheral DMA Controller	PDCA 13					
	14	Peripheral DMA Controller	PDCA 14					
4	0	Flash Controller	FLASHC					
5	0	Universal Synchronous/Asynchronous Receiver/Transmitter	USART0					
6	0	Universal Synchronous/Asynchronous Receiver/Transmitter	USART1					
7	0	Universal Synchronous/Asynchronous Receiver/Transmitter	USART2					
8	0	Universal Synchronous/Asynchronous Receiver/Transmitter	USART3					

 Table 10-3.
 Interrupt Request Signal Map



	interrupt Reques	t Signal Map	
9	0	Serial Peripheral Interface	SPI0
10	0	Serial Peripheral Interface	SPI1
11	0	Two-wire Interface	TWI
12	0	Pulse Width Modulation Controller	PWM
13	0	Synchronous Serial Controller	SSC
	0	Timer/Counter	TC0
14	1	Timer/Counter	TC1
	2	Timer/Counter	TC2
15	0	Analog to Digital Converter	ADC
16	0	Ethernet MAC	MACB
17	0	USB 2.0 OTG Interface	USBB
18	0	SDRAM Controller SDRAMC	
19	0	Audio Bitstream DAC	DAC

 Table 10-3.
 Interrupt Request Signal Map

10.4 Clock Connections

10.4.1 Timer/Counters

Each Timer/Counter channel can independently select an internal or external clock source for its counter:

Source	Name	Connection
Internal	TIMER_CLOCK1	32 KHz Oscillator
	TIMER_CLOCK2	PBA clock / 2
	TIMER_CLOCK3	PBA clock / 8
	TIMER_CLOCK4	PBA clock / 32
	TIMER_CLOCK5	PBA clock / 128
External	XC0	See Section 10.7
	XC1	
	XC2	

 Table 10-4.
 Timer/Counter clock connections

10.4.2 USARTs

Each USART can be connected to an internally divided clock:

USART	Source	Name	Connection				
0	Internal	CLK_DIV	PBA clock / 8				
1							
2							
3							

Table 10-5. USART clock connections



10.4.3 SPIs

Each SPI can be connected to an internally divided clock:

Table 10-6.	SPI	clock conn	ections
	011		000000

SPI	Source	Name	Connection
0	Internal	CLK_DIV	PBA clock or
1			PBA clock / 32

10.5 Nexus OCD AUX port connections

If the OCD trace system is enabled, the trace system will take control over a number of pins, irrespectively of the PIO configuration. Two different OCD trace pin mappings are possible, depending on the configuration of the OCD AXS register. For details, see the AVR32 UC Technical Reference Manual.

	Nexus OCD ADA	port connections
Pin	AXS=0	AXS=1
EVTI_N	PB19	PA08
MDO[5]	PB16	PA27
MDO[4]	PB14	PA26
MDO[3]	PB13	PA25
MDO[2]	PB12	PA24
MDO[1]	PB11	PA23
MDO[0]	PB10	PA22
EVTO_N	PB20	PB20
MCKO	PB21	PA21
MSEO[1]	PB04	PA07
MSEO[0]	PB17	PA28

 Table 10-7.
 Nexus OCD AUX port connections

10.6 PDC handshake signals

The PDC and the peripheral modules communicate through a set of handshake signals. The following table defines the valid settings for the Peripheral Identifier (PID) in the PDC Peripheral Select Register (PSR).

	PDC Handshake Signals
PID Value	Peripheral module & direction
0	ADC
1	SSC - RX
2	USART0 - RX
3	USART1 - RX

Table 10-8. PDC Handshake Signals



Table 10-8.	PDC Handshake Signals
PID Value	Peripheral module & direction
4	USART2 - RX
5	USART3 - RX
6	TWI - RX
7	SPI0 - RX
8	SPI1 - RX
9	SSC - TX
10	USART0 - TX
11	USART1 - TX
12	USART2 - TX
13	USART3 - TX
14	TWI - TX
15	SPI0 - TX
16	SPI1 - TX
17	ABDAC

Table 10-8.PDC Handshake Signals

10.7 Peripheral Multiplexing on I/O lines

Each GPIO line can be assigned to one of 3 peripheral functions; A, B or C. The following table define how the I/O lines on the peripherals A, B and C are multiplexed by the GPIO.

 Table 10-9.
 GPIO Controller Function Multiplexing

TQFP100	VQFP144	PIN	GPIO Pin	Function A	Function B	Function C
19	25	PA00	GPIO 0	USART0 - RXD	TC - CLK0	
20	27	PA01	GPIO 1	USART0 - TXD	TC - CLK1	
23	30	PA02	GPIO 2	USART0 - CLK	TC - CLK2	
24	32	PA03	GPIO 3	USART0 - RTS	EIM - EXTINT[4]	DAC - DATA[0]
25	34	PA04	GPIO 4	USART0 - CTS	EIM - EXTINT[5]	DAC - DATAN[0]
26	39	PA05	GPIO 5	USART1 - RXD	PWM - PWM[4]	
27	41	PA06	GPIO 6	USART1 - TXD	PWM - PWM[5]	
28	43	PA07	GPIO 7	USART1 - CLK	PM - GCLK[0]	SPI0 - NPCS[3]
29	45	PA08	GPIO 8	USART1 - RTS	SPI0 - NPCS[1]	EIM - EXTINT[7]
30	47	PA09	GPIO 9	USART1 - CTS	SPI0 - NPCS[2]	MACB - WOL
31	48	PA10	GPIO 10	SPI0 - NPCS[0]	EIM - EXTINT[6]	
33	50	PA11	GPIO 11	SPI0 - MISO	USB - USB_ID	
36	53	PA12	GPIO 12	SPI0 - MOSI	USB - USB_VBOF	
37	54	PA13	GPIO 13	SPI0 - SCK		
39	56	PA14	GPIO 14	SSC - TX_FRAME_SYNC	SPI1 - NPCS[0]	EBI - NCS[0]
40	57	PA15	GPIO 15	SSC - TX_CLOCK	SPI1 - SCK	EBI - ADDR[20]



 Table 10-9.
 GPIO Controller Function Multiplexing

able 10-9.	GFIO COIII			J		
41	58	PA16	GPIO 16	SSC - TX_DATA	SPI1 - MOSI	EBI - ADDR[21]
42	60	PA17	GPIO 17	SSC - RX_DATA	SPI1 - MISO	EBI - ADDR[22]
43	62	PA18	GPIO 18	SSC - RX_CLOCK	SPI1 - NPCS[1]	MACB - WOL
44	64	PA19	GPIO 19	SSC - RX_FRAME_SYNC	SPI1 - NPCS[2]	
45	66	PA20	GPIO 20	EIM - EXTINT[8]	SPI1 - NPCS[3]	
51	73	PA21	GPIO 21	ADC - AD[0]	EIM - EXTINT[0]	USB - USB_ID
52	74	PA22	GPIO 22	ADC - AD[1]	EIM - EXTINT[1]	USB - USB_VBOF
53	75	PA23	GPIO 23	ADC - AD[2]	EIM - EXTINT[2]	DAC - DATA[1]
54	76	PA24	GPIO 24	ADC - AD[3]	EIM - EXTINT[3]	DAC - DATAN[1]
55	77	PA25	GPIO 25	ADC - AD[4]	EIM - SCAN[0]	EBI - NCS[0]
56	78	PA26	GPIO 26	ADC - AD[5]	EIM - SCAN[1]	EBI - ADDR[20]
57	79	PA27	GPIO 27	ADC - AD[6]	EIM - SCAN[2]	EBI - ADDR[21]
58	80	PA28	GPIO 28	ADC - AD[7]	EIM - SCAN[3]	EBI - ADDR[22]
83	122	PA29	GPIO 29	TWI - SDA	USART2 - RTS	
84	123	PA30	GPIO 30	TWI - SCL	USART2 - CTS	
65	88	PB00	GPIO 32	MACB - TX_CLK	USART2 - RTS	USART3 - RTS
66	90	PB01	GPIO 33	MACB - TX_EN	USART2 - CTS	USART3 - CTS
70	96	PB02	GPIO 34	MACB - TXD[0]	DAC - DATA[0]	
71	98	PB03	GPIO 35	MACB - TXD[1]	DAC - DATAN[0]	
72	100	PB04	GPIO 36	MACB - CRS	USART3 - CLK	EBI - NCS[3]
73	102	PB05	GPIO 37	MACB - RXD[0]	DAC - DATA[1]	
74	104	PB06	GPIO 38	MACB - RXD[1]	DAC - DATAN[1]	
75	106	PB07	GPIO 39	MACB - RX_ER		
76	111	PB08	GPIO 40	MACB - MDC		
77	113	PB09	GPIO 41	MACB - MDIO		
78	115	PB10	GPIO 42	MACB - TXD[2]	USART3 - RXD	EBI - SDCK
81	119	PB11	GPIO 43	MACB - TXD[3]	USART3 - TXD	EBI - SDCKE
82	121	PB12	GPIO 44	MACB - TX_ER	TC - CLK0	EBI - RAS
87	126	PB13	GPIO 45	MACB - RXD[2]	TC - CLK1	EBI - CAS
88	127	PB14	GPIO 46	MACB - RXD[3]	TC - CLK2	EBI - SDWE
95	134	PB15	GPIO 47	MACB - RX_DV		
96	136	PB16	GPIO 48	MACB - COL	USB - USB_ID	EBI - SDA10
98	139	PB17	GPIO 49	MACB - RX_CLK	USB - USB_VBOF	EBI - ADDR[23]
99	141	PB18	GPIO 50	MACB - SPEED	ADC - TRIGGER	PWM - PWM[6]
100	143	PB19	GPIO 51	PWM - PWM[0]	PM - GCLK[0]	EIM - SCAN[4]
1	3	PB20	GPIO 52	PWM - PWM[1]	PM - GCLK[1]	EIM - SCAN[5]
2	5	PB21	GPIO 53	PWM - PWM[2]	PM - GCLK[2]	EIM - SCAN[6]
3	6	PB22	GPIO 54	PWM - PWM[3]	PM - GCLK[3]	EIM - SCAN[7]
6	9	PB23	GPIO 55	TC - A0	USART1 - DCD	
			1			1



 Table 10-9.
 GPIO Controller Function Multiplexing

7 11 PB24 GPIO 56 TC - B0 USART1 - DSR 8 13 PB25 GPIO 57 TC - A1 USART1 - DTR 9 14 PB26 GPIO 58 TC - B1 USART1 - TTR 10 15 PB27 GPIO 59 TC - A2 PVM-PWM[4] 14 19 PB28 GPIO 69 TC - B2 PVM-PWM[5] 16 20 PB29 GPIO 61 USART2 - RXD PM - GCLK[3] EBI - NCS[2] 16 21 PB30 GPIO 63 USART2 - RXD PM - GCLK[3] EBI - NWAIT 63 85 PC001 GPIO 63 USART2 - CLK PM - GCLK[3] EBI - NWAIT 64 86 PC01 GPIO 65 7 22 PB31 GPIO 66 64 12 PC04 GPIO 68 13 PC05 GPIO 98 EBI - DATA[10] USART0 - RXD	Table 10-9.	GPIO CON	roller Functio	niviulupiexing)		
9 14 PB26 GPIO 58 TC - B1 USART1 - R1 10 15 PB27 GPIO 59 TC - A2 PVM - PVM(4) 14 19 PB28 GPIO 60 TC - B2 PVM - PVM(4) 15 20 PB29 GPIO 61 USART2 - RXD PM - GCLK[1] EB1 - NCS[2] 16 21 PB30 GPIO 62 USART2 - RXD PM - GCLK[1] EB1 - NCS[2] 16 21 PB30 GPIO 62 USART2 - RXD PM - GCLK[1] EB1 - NWAIT 63 86 PC01 GPIO 66	7	11	PB24	GPIO 56	TC - B0	USART1 - DSR	
10 15 PB27 GPIO 59 TC - A2 PWM - PWM[4] 14 19 PB28 GPIO 60 TC - B2 PWM - PWM[5] 15 20 PB29 GPIO 61 USART2 - RXD PM - GCL[7] EBI - NCS[2] 16 21 PB30 GPIO 63 USART2 - RXD PM - GCL[7] EBI - NVAIT 63 85 PC00 GPIO 63 USART2 - CLK PM - GCL[7] EBI - NVAIT 64 86 PC01 GPIO 63 USART2 - CLK PM - GCL[7] EBI - NVAIT 65 124 PC02 GPIO 66	8	13	PB25	GPIO 57	TC - A1	USART1 - DTR	
14 19 PB28 GPIO 60 TC - B2 PVM - PVMI(5) 15 20 PB29 GPIO 61 USART2 - RXD PM - GCLK[1] EBI - NCS[2] 16 21 PB30 GPIO 62 USART2 - RXD PM - GCLK[3] EBI - NCS[2] 17 22 PB31 GPIO 63 USART2 - CLK PM - GCLK[3] EBI - NWAIT 63 85 PC00 GPIO 65 64 86 PC01 GPIO 65 64 86 PC02 GPIO 66 85 124 PC02 GPIO 66 93 133 PC05 GPIO 69	9	14	PB26	GPIO 58	TC - B1	USART1 - RI	
15 20 PB29 GPIO 61 USART2 - RXD PM - GCLK[1] EBI - NCS[2] 16 21 PB30 GPIO 62 USART2 - TXD PM - GCLK[2] EBI - SDCS 17 22 PB31 GPIO 63 USART2 - TXD PM - GCLK[3] EBI - NWAIT 63 85 PC00 GPIO 64 PM - GCLK[3] EBI - NWAIT 64 86 PC011 GPIO 65 PM - GCLK[3] EBI - NWAIT 64 86 PC013 GPIO 66 PM - GCLK[3] EBI - NWAIT 85 124 PC02 GPIO 66 PM - GCLK[3] EBI - NMAIT 86 125 PC03 GPIO 67 PM - GCLK[3] USART0 - RTD 93 132 PC04 GPIO 99 EBI - DATA[9] USART0 - RTD 11 PX02 GPIO 99 EBI - DATA[6] USART0 - RTS PM - GCLK[3] 12 PX04 GPIO 96 EBI - DATA[6] USART1 - RXD PM - GCLK[3] 13 PX05 GPIO 93 EBI - DATA[1]	10	15	PB27	GPIO 59	TC - A2	PWM - PWM[4]	
16 21 PB30 GPI0 62 USART2 - TXD PM - GCLK[2] EBI - SDCS 17 22 PB31 GPI0 63 USART2 - CLK PM - GCLK[3] EBI - NWAIT 63 85 PC00 GPI0 65 64 86 PC01 GPI0 65 85 124 PC02 GPI0 66 86 125 PC03 GPI0 66 93 132 PC04 GPI0 69 94 133 PC05 GPI0 99 EBI - DATA[10] USART0 - RXD <	14	19	PB28	GPIO 60	TC - B2	PWM - PWM[5]	
17 22 PB31 GPIO 63 USART2 - CLK PM - GCLK[3] EBI - NWAIT 63 85 PC00 GPIO 64 64 86 PC01 GPIO 65 85 124 PC02 GPIO 66 86 125 PC03 GPIO 68 93 132 PC04 GPIO 68 94 133 PC05 GPIO 69 <	15	20	PB29	GPIO 61	USART2 - RXD	PM - GCLK[1]	EBI - NCS[2]
63 85 PC00 GPI0 64 Image: Constraint of the second	16	21	PB30	GPIO 62	USART2 - TXD	PM - GCLK[2]	EBI - SDCS
64 86 PC01 GPI0 65 Image: Constraint of the second	17	22	PB31	GPIO 63	USART2 - CLK	PM - GCLK[3]	EBI - NWAIT
85 124 PC02 GPI0 66 Image: Constraint of the state of the	63	85	PC00	GPIO 64			
86 125 PC03 GPI0 67 Constant Constant 93 132 PC04 GPI0 68 Constant Constant 94 133 PC05 GPI0 69 Constant Constant 94 133 PC05 GPI0 99 EBI - DATA[10] USART0 - RXD 2 PX01 GPI0 99 EBI - DATA[9] USART0 - RXD Constant 10 PX02 GPI0 98 EBI - DATA[7] USART0 - RTS Constant 11 PX03 GPI0 97 EBI - DATA[8] USART1 - RXD Constant 12 PX04 GPI0 95 EBI - DATA[5] USART1 - RXD Constant 26 PX06 GPI0 91 EBI - DATA[1] USART1 - RXD Constant 33 PX08 GPI0 92 EBI - DATA[1] USART1 - RXD Constant 33 PX08 GPI0 92 EBI - DATA[1] USART2 - RXD Constant 44 PX13 GPI0 91 EBI - NME10 USART2 - RXD Constant	64	86	PC01	GPIO 65			
93 132 PC04 GPIO 68 Image: Constant of the state of the s	85	124	PC02	GPIO 66			
94 133 PC05 GPIO 69 CEN LEARTO - RXD 1 PX00 GPIO 100 EBI - DATA[10] USARTO - RXD 2 PX01 GPIO 99 EBI - DATA[9] USARTO - RXD 4 PX02 GPIO 98 EBI - DATA[9] USARTO - TXD 10 PX03 GPIO 97 EBI - DATA[7] USARTO - CTS 110 PX04 GPIO 96 EBI - DATA[6] USARTI - RXD 122 PX04 GPIO 96 EBI - DATA[5] USARTI - RXD 244 PX05 GPIO 97 EBI - DATA[1] USARTI - RXD 311 PX07 GPIO 98 EBI - DATA[1] USARTI - RXD 333 PX08 GPIO 91 EBI - DATA[1] USART3 - RXD 333 PX08 GPIO 90 EBI - DATA[1] USART2 - RXD 440 PX11 GPIO 109 EBI - NWE1 USART2 - RXD 444 PX13 GPIO 106 EBI - NCS[1] TC - A0 444 PX13 GPIO 106 EBI - NCS[1] TC	86	125	PC03	GPIO 67			
1 PX00 GPI0 100 EBI - DATA[10] USART0 - RXD 2 PX01 GPI0 99 EBI - DATA[9] USART0 - TXD 4 PX02 GPI0 98 EBI - DATA[8] USART0 - TXD 10 PX03 GPI0 97 EBI - DATA[8] USART0 - TXD 110 PX03 GPI0 97 EBI - DATA[7] USART0 - RTS 112 PX04 GPI0 96 EBI - DATA[6] USART1 - RXD 244 PX05 GPI0 95 EBI - DATA[5] USART1 - TXD 266 PX06 GPI0 93 EBI - DATA[1] USART1 - RTS 31 PX07 GPI0 93 EBI - DATA[2] USART1 - RTS 33 PX08 GPI0 92 EBI - DATA[1] USART3 - RXD 33 PX09 GPI0 91 EBI - DATA[1] USART3 - RXD 33 PX09 GPI0 92 EBI - DATA[1] USART3 - RXD 440 PX11 GPI0 90 EBI - NXE11 USART2 - RXD 441 PX13 GPI0 107 EBI - NXE1 USART3 - RTS<	93	132	PC04	GPIO 68			
2 PX01 GPI0 99 EBI-DATA[9] USART0 - TXD 4 PX02 GPI0 98 EBI-DATA[8] USART0 - TXD 10 PX03 GPI0 97 EBI-DATA[8] USART0 - TXD 112 PX04 GPI0 96 EBI-DATA[6] USART0 - RTS 12 PX04 GPI0 96 EBI-DATA[6] USART1 - RXD 24 PX05 GPI0 95 EBI-DATA[6] USART1 - RXD 26 PX06 GPI0 94 EBI-DATA[3] USART1 - RTS 31 PX07 GPI0 93 EBI-DATA[2] USART3 - RXD 33 PX08 GPI0 92 EBI-DATA[1] USART3 - RXD 33 PX08 GPI0 92 EBI-DATA[1] USART3 - RXD 34 PX10 GPI0 90 EBI-DATA[1] USART3 - RXD 38 PX10 GPI0 109 EBI-NATA[0] USART2 - RXD 440 PX11 GPI0 107 EBI-NNE1 USART2 - RXD 441 PX13 GPI0 107 EBI-NDC[1] TC - A0 <t< td=""><td>94</td><td>133</td><td>PC05</td><td>GPIO 69</td><td></td><td></td><td></td></t<>	94	133	PC05	GPIO 69			
4 PX02 GPI0 98 EBI-DATA[8] USART0-CTS 10 PX03 GPI0 97 EBI-DATA[7] USART0-RTS 12 PX04 GPI0 96 EBI-DATA[6] USART1-RXD 24 PX05 GPI0 95 EBI-DATA[5] USART1-RXD 26 PX06 GPI0 94 EBI-DATA[3] USART1-TXD 31 PX07 GPI0 93 EBI-DATA[3] USART1-RTS 33 PX08 GPI0 92 EBI-DATA[1] USART3-RXD 33 PX08 GPI0 92 EBI-DATA[1] USART3-RXD 34 PX10 GPI0 90 EBI-DATA[1] USART3-RXD 38 PX10 GPI0 90 EBI-DATA[0] USART3-RXD 40 PX11 GPI0 109 EBI-NWE1 USART2-RXD 44 PX13 GPI0 107 EBI-NWE0 USART2-CTS 444 PX13 GPI0 106 EBI-NCS[1] TC-A0 59 PX15 GPI0 88 EBI-ADDR[18] USART3-RTS TC-B0 61 <td></td> <td>1</td> <td>PX00</td> <td>GPIO 100</td> <td>EBI - DATA[10]</td> <td>USART0 - RXD</td> <td></td>		1	PX00	GPIO 100	EBI - DATA[10]	USART0 - RXD	
10 PX03 GPIO 97 EBI - DATA[7] USARTO - RTS 12 PX04 GPIO 96 EBI - DATA[6] USART1 - RXD 24 PX05 GPIO 95 EBI - DATA[6] USART1 - RXD 26 PX06 GPIO 94 EBI - DATA[5] USART1 - RTS 31 PX07 GPIO 93 EBI - DATA[3] USART1 - RTS 33 PX08 GPIO 92 EBI - DATA[2] USART3 - RXD 33 PX08 GPIO 91 EBI - DATA[1] USART3 - RXD 36 PX09 GPIO 90 EBI - DATA[1] USART2 - RXD 38 PX10 GPIO 90 EBI - NWE1 USART2 - RXD 40 PX11 GPIO 108 EBI - NWE0 USART2 - RXD 44 PX13 GPIO 107 EBI - NRD USART2 - GRI 44 PX13 GPIO 106 EBI - NCS[1] TC - A0 59 PX14 GPIO 88 EBI - ADDR[18] USART3 - RTS TC - B0 61 PX16 GPIO 87 EBI - ADDR[17]		2	PX01	GPIO 99	EBI - DATA[9]	USART0 - TXD	
12 PX04 GPI0 96 EBI - DATA[6] USART1 - RXD 24 PX05 GPI0 95 EBI - DATA[5] USART1 - TXD 26 PX06 GPI0 94 EBI - DATA[4] USART1 - CTS 31 PX07 GPI0 93 EBI - DATA[3] USART1 - RXD 33 PX08 GPI0 92 EBI - DATA[2] USART3 - RXD 33 PX08 GPI0 90 EBI - DATA[1] USART3 - RXD 35 PX09 GPI0 90 EBI - DATA[2] USART3 - RXD 38 PX10 GPI0 90 EBI - DATA[1] USART3 - TXD 40 PX11 GPI0 109 EBI - NXE1 USART2 - RXD 40 PX11 GPI0 108 EBI - NXE0 USART2 - CTS 44 PX13 GPI0 107 EBI - NXE0 USART3 - RTS TC - A0 59 PX14 GPI0 108 EBI - NXE0 USART3 - RTS TC - A0 59 PX14 GPI0 88 EBI - NDR[19] USART3 - RTS TC - A0 61 PX16 GPI		4	PX02	GPIO 98	EBI - DATA[8]	USART0 - CTS	
24 PX05 GPIO 95 EBI - DATA[5] USART1 - TXD 26 PX06 GPIO 94 EBI - DATA[4] USART1 - TXS 31 PX07 GPIO 93 EBI - DATA[3] USART1 - RTS 33 PX08 GPIO 92 EBI - DATA[2] USART3 - RXD 33 PX08 GPIO 92 EBI - DATA[2] USART3 - RXD 35 PX09 GPIO 91 EBI - DATA[1] USART3 - RXD 38 PX10 GPIO 90 EBI - DATA[0] USART2 - RXD 40 PX11 GPIO 109 EBI - NWE1 USART2 - RXD 42 PX12 GPIO 108 EBI - NWE0 USART2 - CTS 44 PX13 GPIO 107 EBI - NRD USART3 - RXD 44 PX13 GPIO 107 EBI - NRD USART3 - CTS 444 PX13 GPIO 106 EBI - NCS[1] TC - A0 59 PX15 GPIO 88 EBI - ADDR[19] USART3 - CTS TC - A1 61 PX16 GPIO 87 EBI - ADDR[17] T		10	PX03	GPIO 97	EBI - DATA[7]	USART0 - RTS	
26 PX06 GPIO 94 EBI - DATA[4] USART1 - CTS 31 PX07 GPIO 93 EBI - DATA[3] USART1 - RTS 33 PX08 GPIO 92 EBI - DATA[2] USART1 - RTS 33 PX08 GPIO 92 EBI - DATA[2] USART3 - RXD 35 PX09 GPIO 90 EBI - DATA[1] USART3 - RXD 36 PX10 GPIO 90 EBI - DATA[0] USART2 - RXD 40 PX11 GPIO 90 EBI - NWE1 USART2 - RXD 40 PX12 GPIO 108 EBI - NWE0 USART2 - CTS 44 PX13 GPIO 107 EBI - NRD USART2 - RTS 444 PX13 GPIO 106 EBI - NCS[1] TC - A0 59 PX15 GPIO 88 EBI - ADDR[19] USART3 - RTS TC - B1 61 PX16 GPIO 87 EBI - ADDR[17] TC - A1 TC - A2 65 PX18 GPIO 85 EBI - ADDR[16] USART3 - CTS TC - A1 65 PX18 GPIO 85 </td <td></td> <td>12</td> <td>PX04</td> <td>GPIO 96</td> <td>EBI - DATA[6]</td> <td>USART1 - RXD</td> <td></td>		12	PX04	GPIO 96	EBI - DATA[6]	USART1 - RXD	
31 PX07 GPI0 93 EBI - DATA[3] USART1 - RTS 33 PX08 GPI0 92 EBI - DATA[2] USART3 - RXD 35 PX09 GPI0 91 EBI - DATA[1] USART3 - RXD 35 PX09 GPI0 90 EBI - DATA[1] USART3 - RXD 38 PX10 GPI0 90 EBI - DATA[0] USART2 - RXD 400 PX11 GPI0 109 EBI - NWE1 USART2 - RXD 42 PX12 GPI0 108 EBI - NWE0 USART2 - CTS 44 PX13 GPI0 107 EBI - NRD USART2 - RXD 444 PX13 GPI0 107 EBI - NRD USART2 - RXD 444 PX13 GPI0 106 EBI - NRD USART3 - CTS 446 PX14 GPI0 89 EBI - NDS[1] TC - A0 59 PX15 GPI0 88 EBI - ADDR[19] USART3 - CTS TC - A1 61 PX16 GPI0 87 EBI - ADDR[17] TC - A1 TC - A2 65 PX18 GPI0 86 EBI - ADDR[15		24	PX05	GPIO 95	EBI - DATA[5]	USART1 - TXD	
A PX08 GPIO 92 EBI - DATA[2] USART3 - RXD 33 PX08 GPIO 91 EBI - DATA[1] USART3 - RXD 36 PX09 GPIO 90 EBI - DATA[1] USART3 - RXD 38 PX10 GPIO 90 EBI - DATA[0] USART2 - RXD 40 PX11 GPIO 109 EBI - NWE1 USART2 - RXD 42 PX12 GPIO 109 EBI - NWE0 USART2 - CTS 44 PX13 GPIO 107 EBI - NRD USART2 - RXD 444 PX13 GPIO 107 EBI - NRD USART2 - RTS 446 PX14 GPIO 106 EBI - NCS[1] TC - A0 59 PX15 GPIO 88 EBI - ADDR[19] USART3 - RTS TC - A0 61 PX16 GPIO 88 EBI - ADDR[19] USART3 - CTS TC - A1 663 PX17 GPIO 87 EBI - ADDR[18] USART3 - CTS TC - A1 665 PX18 GPIO 86 EBI - ADDR[16] TC - A2 TC - A2 670 PX19		26	PX06	GPIO 94	EBI - DATA[4]	USART1 - CTS	
35 PX09 GPIO 91 EBI - DATA[1] USART3 - TXD 38 PX10 GPIO 90 EBI - DATA[0] USART2 - RXD 40 PX11 GPIO 109 EBI - NWE1 USART2 - RXD 40 PX11 GPIO 109 EBI - NWE1 USART2 - TXD 42 PX12 GPIO 108 EBI - NWE0 USART2 - CTS 44 PX13 GPIO 107 EBI - NRD USART2 - RXD 44 PX13 GPIO 107 EBI - NRD USART2 - RXS 44 PX13 GPIO 106 EBI - NRD USART2 - RXS 46 PX14 GPIO 106 EBI - NRD USART3 - RTS 59 PX15 GPIO 89 EBI - ADDR[19] USART3 - CTS TC - A0 61 PX16 GPIO 88 EBI - ADDR[18] USART3 - CTS TC - A1 63 PX17 GPIO 87 EBI - ADDR[17] TC - B1 TC - A2 661 PX18 GPIO 85 EBI - ADDR[16] TC - A2 TC - A2 67 PX19		31	PX07	GPIO 93	EBI - DATA[3]	USART1 - RTS	
38 PX10 GPIO 90 EBI - DATA[0] USART2 - RXD 40 PX11 GPIO 109 EBI - NWE1 USART2 - TXD 42 PX12 GPIO 108 EBI - NWE0 USART2 - CTS 44 PX13 GPIO 107 EBI - NWE0 USART2 - RTS 44 PX13 GPIO 106 EBI - NRD USART2 - RTS 46 PX14 GPIO 106 EBI - NCS[1] TC - A0 59 PX15 GPIO 89 EBI - ADDR[19] USART3 - RTS TC - A1 61 PX16 GPIO 88 EBI - ADDR[18] USART3 - CTS TC - A1 63 PX17 GPIO 87 EBI - ADDR[17] TC - A1 65 PX18 GPIO 85 EBI - ADDR[16] TC - A2 667 PX19 GPIO 85 EBI - ADDR[16] TC - CLK0 87 PX20 GPIO 84 EBI - ADDR[14] EIM - SCAN[0] TC - CLK0 89 PX21 GPIO 83 EBI - ADDR[13] EIM - SCAN[2] TC - CLK1 91 PX22<		33	PX08	GPIO 92	EBI - DATA[2]	USART3 - RXD	
A0 PX11 GPIO 109 EBI - NWE1 USART2 - TXD 42 PX12 GPIO 108 EBI - NWE0 USART2 - CTS 44 PX13 GPIO 107 EBI - NRD USART2 - RTS 44 PX14 GPIO 106 EBI - NCS[1] TC - A0 59 PX15 GPIO 89 EBI - ADDR[19] USART3 - RTS TC - B0 61 PX16 GPIO 88 EBI - ADDR[18] USART3 - CTS TC - A1 63 PX17 GPIO 87 EBI - ADDR[18] USART3 - CTS TC - A1 63 PX17 GPIO 88 EBI - ADDR[18] USART3 - CTS TC - A1 64 PX18 GPIO 86 EBI - ADDR[17] TC - A1 TC - A1 65 PX18 GPIO 85 EBI - ADDR[16] TC - A2 TC - A2 67 PX19 GPIO 85 EBI - ADDR[14] EIM - SCAN[0] TC - CLK0 87 PX20 GPIO 84 EBI - ADDR[14] EIM - SCAN[2] TC - CLK1 89 PX21 GPIO 82		35	PX09	GPIO 91	EBI - DATA[1]	USART3 - TXD	
42 PX12 GPIO 108 EBI - NWE0 USART2 - CTS 44 PX13 GPIO 107 EBI - NRD USART2 - RTS 46 PX14 GPIO 106 EBI - NCS[1] TC - A0 59 PX15 GPIO 89 EBI - ADDR[19] USART3 - RTS TC - A0 61 PX16 GPIO 88 EBI - ADDR[18] USART3 - CTS TC - A1 63 PX17 GPIO 87 EBI - ADDR[17] TC - B1 65 PX18 GPIO 86 EBI - ADDR[16] TC - A2 667 PX19 GPIO 85 EBI - ADDR[15] EIM - SCAN[0] TC - CLK0 87 PX20 GPIO 83 EBI - ADDR[13] EIM - SCAN[1] TC - CLK0 89 PX21 GPIO 83 EBI - ADDR[13] EIM - SCAN[2] TC - CLK1 95 PX23 GPIO 81 EBI - ADDR[12] EIM - SCAN[3] TC - CLK2		38	PX10	GPIO 90	EBI - DATA[0]	USART2 - RXD	
44 PX13 GPIO 107 EBI - NRD USART2 - RTS 46 PX14 GPIO 106 EBI - NCS[1] TC - A0 59 PX15 GPIO 89 EBI - ADDR[19] USART3 - RTS TC - A0 61 PX16 GPIO 88 EBI - ADDR[19] USART3 - CTS TC - A1 63 PX17 GPIO 87 EBI - ADDR[17] TC - B1 63 PX17 GPIO 86 EBI - ADDR[16] TC - A2 65 PX18 GPIO 86 EBI - ADDR[16] TC - A2 67 PX19 GPIO 85 EBI - ADDR[16] TC - B2 87 PX20 GPIO 84 EBI - ADDR[14] EIM - SCAN[0] TC - CLK0 89 PX21 GPIO 83 EBI - ADDR[13] EIM - SCAN[2] TC - CLK1 91 PX22 GPIO 82 EBI - ADDR[12] EIM - SCAN[3] TC - CLK2 95 PX23 GPIO 84 EBI - ADDR[12] EIM - SCAN[4] TC - CLK2		40	PX11	GPIO 109	EBI - NWE1	USART2 - TXD	
46 PX14 GPIO 106 EBI - NCS[1] TC - A0 59 PX15 GPIO 89 EBI - ADDR[19] USART3 - RTS TC - B0 61 PX16 GPIO 88 EBI - ADDR[18] USART3 - CTS TC - A1 63 PX17 GPIO 87 EBI - ADDR[17] TC - B1 63 PX18 GPIO 86 EBI - ADDR[16] TC - A2 65 PX18 GPIO 86 EBI - ADDR[16] TC - A2 67 PX19 GPIO 85 EBI - ADDR[15] EIM - SCAN[0] TC - B2 87 PX20 GPIO 84 EBI - ADDR[13] EIM - SCAN[1] TC - CLK0 89 PX21 GPIO 83 EBI - ADDR[13] EIM - SCAN[2] TC - CLK1 91 PX22 GPIO 82 EBI - ADDR[12] EIM - SCAN[3] TC - CLK2 95 PX23 GPIO 81 EBI - ADDR[11] EIM - SCAN[4] EIM - SCAN[4]		42	PX12	GPIO 108	EBI - NWE0	USART2 - CTS	
59 PX15 GPIO 89 EBI - ADDR[19] USART3 - RTS TC - B0 61 PX16 GPIO 88 EBI - ADDR[18] USART3 - CTS TC - A1 63 PX17 GPIO 87 EBI - ADDR[17] TC - B1 65 PX18 GPIO 86 EBI - ADDR[16] TC - A2 67 PX19 GPIO 85 EBI - ADDR[15] EIM - SCAN[0] TC - B2 87 PX20 GPIO 84 EBI - ADDR[14] EIM - SCAN[1] TC - CLK0 89 PX21 GPIO 83 EBI - ADDR[12] EIM - SCAN[2] TC - CLK1 91 PX22 GPIO 84 EBI - ADDR[12] EIM - SCAN[3] TC - CLK2 95 PX23 GPIO 81 EBI - ADDR[11] EIM - SCAN[4] EIM - SCAN[4]		44	PX13	GPIO 107	EBI - NRD	USART2 - RTS	
61 PX16 GPIO 88 EBI - ADDR[18] USART3 - CTS TC - A1 63 PX17 GPIO 87 EBI - ADDR[17] TC - B1 65 PX18 GPIO 86 EBI - ADDR[16] TC - A2 65 PX19 GPIO 85 EBI - ADDR[15] EIM - SCAN[0] TC - B2 67 PX20 GPIO 84 EBI - ADDR[14] EIM - SCAN[1] TC - CLK0 87 PX20 GPIO 83 EBI - ADDR[13] EIM - SCAN[2] TC - CLK1 91 PX22 GPIO 82 EBI - ADDR[12] EIM - SCAN[3] TC - CLK2 95 PX23 GPIO 81 EBI - ADDR[11] EIM - SCAN[4] EIM - SCAN[4]		46	PX14	GPIO 106	EBI - NCS[1]		TC - A0
63 PX17 GPIO 87 EBI - ADDR[17] TC - B1 65 PX18 GPIO 86 EBI - ADDR[16] TC - A2 67 PX19 GPIO 85 EBI - ADDR[15] EIM - SCAN[0] TC - B2 87 PX20 GPIO 83 EBI - ADDR[14] EIM - SCAN[1] TC - CLK0 89 PX21 GPIO 83 EBI - ADDR[13] EIM - SCAN[2] TC - CLK1 91 PX22 GPIO 81 EBI - ADDR[12] EIM - SCAN[3] TC - CLK2 95 PX23 GPIO 81 EBI - ADDR[11] EIM - SCAN[4] EIM - SCAN[4]		59	PX15	GPIO 89	EBI - ADDR[19]	USART3 - RTS	TC - B0
65 PX18 GPIO 86 EBI - ADDR[16] TC - A2 67 PX19 GPIO 85 EBI - ADDR[15] EIM - SCAN[0] TC - B2 87 PX20 GPIO 84 EBI - ADDR[14] EIM - SCAN[1] TC - CLK0 89 PX21 GPIO 83 EBI - ADDR[13] EIM - SCAN[2] TC - CLK1 91 PX22 GPIO 82 EBI - ADDR[12] EIM - SCAN[3] TC - CLK2 95 PX23 GPIO 81 EBI - ADDR[11] EIM - SCAN[4] EIM - SCAN[4]		61	PX16	GPIO 88	EBI - ADDR[18]	USART3 - CTS	TC - A1
67 PX19 GPIO 85 EBI - ADDR[15] EIM - SCAN[0] TC - B2 87 PX20 GPIO 84 EBI - ADDR[14] EIM - SCAN[1] TC - CLK0 89 PX21 GPIO 83 EBI - ADDR[13] EIM - SCAN[2] TC - CLK1 91 PX22 GPIO 82 EBI - ADDR[12] EIM - SCAN[3] TC - CLK2 95 PX23 GPIO 81 EBI - ADDR[11] EIM - SCAN[4] EIM - SCAN[4]		63	PX17	GPIO 87	EBI - ADDR[17]		TC - B1
87 PX20 GPIO 84 EBI - ADDR[14] EIM - SCAN[1] TC - CLK0 89 PX21 GPIO 83 EBI - ADDR[13] EIM - SCAN[2] TC - CLK1 91 PX22 GPIO 82 EBI - ADDR[12] EIM - SCAN[3] TC - CLK2 95 PX23 GPIO 81 EBI - ADDR[11] EIM - SCAN[4] EIM - SCAN[4]		65	PX18	GPIO 86	EBI - ADDR[16]		TC - A2
89 PX21 GPIO 83 EBI - ADDR[13] EIM - SCAN[2] TC - CLK1 91 PX22 GPIO 82 EBI - ADDR[12] EIM - SCAN[3] TC - CLK2 95 PX23 GPIO 81 EBI - ADDR[11] EIM - SCAN[4] EIM - SCAN[4]		67	PX19	GPIO 85	EBI - ADDR[15]	EIM - SCAN[0]	TC - B2
91 PX22 GPIO 82 EBI - ADDR[12] EIM - SCAN[3] TC - CLK2 95 PX23 GPIO 81 EBI - ADDR[11] EIM - SCAN[4]		87	PX20	GPIO 84	EBI - ADDR[14]	EIM - SCAN[1]	TC - CLK0
95 PX23 GPIO 81 EBI - ADDR[11] EIM - SCAN[4]		89	PX21	GPIO 83	EBI - ADDR[13]	EIM - SCAN[2]	TC - CLK1
		91	PX22	GPIO 82	EBI - ADDR[12]	EIM - SCAN[3]	TC - CLK2
		95	PX23	GPIO 81	EBI - ADDR[11]	EIM - SCAN[4]	
97 PX24 GPIO 80 EBI - ADDR[10] EIM - SCAN[5]		97	PX24	GPIO 80	EBI - ADDR[10]	EIM - SCAN[5]	



		1 6			
99	PX25	GPIO 79	EBI - ADDR[9]	EIM - SCAN[6]	
101	PX26	GPIO 78	EBI - ADDR[8]	EIM - SCAN[7]	
103	PX27	GPIO 77	EBI - ADDR[7]	SPI0 - MISO	
105	PX28	GPIO 76	EBI - ADDR[6]	SPI0 - MOSI	
107	PX29	GPIO 75	EBI - ADDR[5]	SPI0 - SCK	
110	PX30	GPIO 74	EBI - ADDR[4]	SPI0 - NPCS[0]	
112	PX31	GPIO 73	EBI - ADDR[3]	SPI0 - NPCS[1]	
114	PX32	GPIO 72	EBI - ADDR[2]	SPI0 - NPCS[2]	
118	PX33	GPIO 71	EBI - ADDR[1]	SPI0 - NPCS[3]	
120	PX34	GPIO 70	EBI - ADDR[0]	SPI1 - MISO	
135	PX35	GPIO 105	EBI - DATA[15]	SPI1 - MOSI	
137	PX36	GPIO 104	EBI - DATA[14]	SPI1 - SCK	
140	PX37	GPIO 103	EBI - DATA[13]	SPI1 - NPCS[0]	
142	PX38	GPIO 102	EBI - DATA[12]	SPI1 - NPCS[1]	
144	PX39	GPIO 101	EBI - DATA[11]	SPI1 - NPCS[2]	

Table 10-9. GPIO Controller Function Multiplexing

10.8 Oscillator Pinout

The oscillators are not mapped to the normal A,B or C functions and their muxings are controlled by registers in the Power Manager (PM). Please refer to the power manager chapter for more information about this.

TQFP100 pin	VQFP144 pin	Pad	Oscillator pin
85	124	PC02	xin0
93	132	PC04	xin1
63	85	PC00	xin32
86	125	PC03	xout0
94	133	PC05	xout1
64	86	PC01	xout32

Table 10-10. Oscillator pinout

10.9 USART Configuration

Table 10-11.	USART Supported Mode
--------------	----------------------

	SPI	RS485	ISO7816	IrDA	Modem	Manchester Encoding
USART0	Yes	No	No	No	No	No
USART1	Yes	Yes	Yes	Yes	Yes	Yes
USART2	Yes	No	No	No	No	No
USART3	Yes	No	No	No	No	No



10.10 GPIO

The GPIO open drain feature (GPIO ODMER register (Open Drain Mode Enable Register)) is not available for this device.

10.11 Peripheral overview

10.11.1 External Bus Interface

- Optimized for Application Memory Space support
- Integrates Two External Memory Controllers:
 - Static Memory Controller
 - SDRAM Controller
- Optimized External Bus:
 - 16-bit Data Bus
 - 24-bit Address Bus, Up to 16-Mbytes Addressable
 - Optimized pin multiplexing to reduce latencies on External Memories
- 4 SRAM Chip Selects, 1SDRAM Chip Select:
 - Static Memory Controller on NCS0
 - SDRAM Controller or Static Memory Controller on NCS1
 - Static Memory Controller on NCS2
 - Static Memory Controller on NCS3

10.11.2 Static Memory Controller

- 4 Chip Selects Available
- 64-Mbyte Address Space per Chip Select
- 8-, 16-bit Data Bus
- Word, Halfword, Byte Transfers
- Byte Write or Byte Select Lines
- Programmable Setup, Pulse And Hold Time for Read Signals per Chip Select
- Programmable Setup, Pulse And Hold Time for Write Signals per Chip Select
- Programmable Data Float Time per Chip Select
- Compliant with LCD Module
- External Wait Request
- Automatic Switch to Slow Clock Mode
- Asynchronous Read in Page Mode Supported: Page Size Ranges from 4 to 32 Bytes

10.11.3 SDRAM Controller

- Numerous Configurations Supported
 - 2K, 4K, 8K Row Address Memory Parts
 - SDRAM with Two or Four Internal Banks
 - SDRAM with 16-bit Data Path
- Programming Facilities
 - Word, Half-word, Byte Access
 - Automatic Page Break When Memory Boundary Has Been Reached
 - Multibank Ping-pong Access
 - Timing Parameters Specified by Software
 - Automatic Refresh Operation, Refresh Rate is Programmable
- Energy-saving Capabilities
 - Self-refresh, Power-down and Deep Power Modes Supported



- Supports Mobile SDRAM Devices
- Error Detection
 - Refresh Error Interrupt
- SDRAM Power-up Initialization by Software
- CAS Latency of 1, 2, 3 Supported
- Auto Precharge Command Not Used

10.11.4 USB Controller

- USB 2.0 Compliant, Full-/Low-Speed (FS/LS) and On-The-Go (OTG), 12 Mbit/s
- 7 Pipes/Endpoints
- 960 bytes of Embedded Dual-Port RAM (DPRAM) for Pipes/Endpoints
- Up to 2 Memory Banks per Pipe/Endpoint (Not for Control Pipe/Endpoint)
- Flexible Pipe/Endpoint Configuration and Management with Dedicated DMA Channels
- On-Chip Transceivers Including Pull-Ups

10.11.5 Serial Peripheral Interface

- Supports communication with serial external devices
 - Four chip selects with external decoder support allow communication with up to 15 peripherals
 - Serial memories, such as DataFlash and 3-wire EEPROMs
 - Serial peripherals, such as ADCs, DACs, LCD Controllers, CAN Controllers and Sensors
 - External co-processors
- Master or slave serial peripheral bus interface
 - 8- to 16-bit programmable data length per chip select
 - Programmable phase and polarity per chip select
 - Programmable transfer delays between consecutive transfers and between clock and data per chip select
 - Programmable delay between consecutive transfers
 - Selectable mode fault detection
- Very fast transfers supported
 - Transfers with baud rates up to Peripheral Bus A (PBA) max frequency
 - The chip select line may be left active to speed up transfers on the same device

10.11.6 Two-wire Interface

- High speed up to 400kbit/s
- · Compatibility with standard two-wire serial memory
- One, two or three bytes for slave address
- Sequential read/write operations

10.11.7 USART

- Programmable Baud Rate Generator
- 5- to 9-bit full-duplex synchronous or asynchronous serial communications
 - 1, 1.5 or 2 stop bits in Asynchronous Mode or 1 or 2 stop bits in Synchronous Mode
 - Parity generation and error detection
 - Framing error detection, overrun error detection
 - MSB- or LSB-first
 - Optional break generation and detection
 - By 8 or by-16 over-sampling receiver frequency
 - Hardware handshaking RTS-CTS
 - Receiver time-out and transmitter timeguard
 - Optional Multi-drop Mode with address generation and detection



- Optional Manchester Encoding
- RS485 with driver control signal
- ISO7816, T = 0 or T = 1 Protocols for interfacing with smart cards
- NACK handling, error counter with repetition and iteration limit
- IrDA modulation and demodulation
 - Communication at up to 115.2 Kbps
- Test Modes
 - Remote Loopback, Local Loopback, Automatic Echo
- SPI Mode
 - Master or Slave
 - Serial Clock Programmable Phase and Polarity
 - SPI Serial Clock (SCK) Frequency up to Internal Clock Frequency PBA/4
- Supports Connection of Two Peripheral DMA Controller Channels (PDC)
 - Offers Buffer Transfer without Processor Intervention

10.11.8 Serial Synchronous Controller

- Provides serial synchronous communication links used in audio and telecom applications (with CODECs in Master or Slave Modes, I2S, TDM Buses, Magnetic Card Reader, etc.)
- · Contains an independent receiver and transmitter and a common clock divider
- Offers a configurable frame sync and data length
- Receiver and transmitter can be programmed to start automatically or on detection of different event on the frame sync signal
- Receiver and transmitter include a data signal, a clock signal and a frame synchronization signal
- 10.11.9 Timer Counter
- Three 16-bit Timer Counter Channels
- Wide range of functions including:
 - Frequency Measurement
 - Event Counting
 - Interval Measurement
 - Pulse Generation
 - Delay Timing
 - Pulse Width Modulation
 - Up/down Capabilities
- Each channel is user-configurable and contains:
 - Three external clock inputs
 - Five internal clock inputs
 - Two multi-purpose input/output signals
- Two global registers that act on all three TC Channels

10.11.10 Pulse Width Modulation Controller

- 7 channels, one 20-bit counter per channel
- Common clock generator, providing Thirteen Different Clocks
 - A Modulo n counter providing eleven clocks
 - Two independent Linear Dividers working on modulo n counter outputs
- Independent channel programming
 - Independent Enable Disable Commands
 - Independent Clock
 - Independent Period and Duty Cycle, with Double Bufferization
 - Programmable selection of the output waveform polarity
 - Programmable center or left aligned output waveform



10.11.11 Ethernet 10/100 MAC

- Compatibility with IEEE Standard 802.3
- 10 and 100 Mbits per second data throughput capability
- Full- and half-duplex operations
- MII or RMII interface to the physical layer
- Register Interface to address, data, status and control registers
- DMA Interface, operating as a master on the Memory Controller
- Interrupt generation to signal receive and transmit completion
- 28-byte transmit and 28-byte receive FIFOs
- Automatic pad and CRC generation on transmitted frames
- Address checking logic to recognize four 48-bit addresses
- · Support promiscuous mode where all valid frames are copied to memory
- Support physical layer management through MDIO interface control of alarm and update time/calendar data

10.11.12 Audio Bitstream DAC

- Digital Stereo DAC
- Oversampled D/A conversion architecture
 - Oversampling ratio fixed 128x
 - FIR equalization filter
 - Digital interpolation filter: Comb4
 - 3rd Order Sigma-Delta D/A converters
- Digital bitstream outputs
- Parallel interface
- Connected to Peripheral DMA Controller for background transfer without CPU intervention



11. Boot Sequence

This chapter summarizes the boot sequence of the AT32UC3A. The behaviour after power-up is controlled by the Power Manager. For specific details, refer to Section 13. "Power Manager (PM)" on page 53.

11.1 Starting of clocks

After power-up, the device will be held in a reset state by the Power-On Reset circuitry, until the power has stabilized throughout the device. Once the power has stabilized, the device will use the internal RC Oscillator as clock source.

On system start-up, the PLLs are disabled. All clocks to all modules are running. No clocks have a divided frequency, all parts of the system recieves a clock with the same frequency as the internal RC Oscillator.

11.2 Fetching of initial instructions

After reset has been released, the AVR32 UC CPU starts fetching instructions from the reset address, which is 0x8000_0000. This address points to the first address in the internal Flash.

The code read from the internal Flash is free to configure the system to use for example the PLLs, to divide the frequency of the clock routed to some of the peripherals, and to gate the clocks to unused peripherals.



12. Electrical Characteristics

12.1 Absolute Maximum Ratings*

Operating Temperature40.C to +85.C
Storage Temperature60°C to +150°C
Voltage on Input Pin with respect to Ground except for PC00, PC01, PC02, PC03, PC04, PC050.3V to 5.5V
Voltage on Input Pin with respect to Ground for PC00, PC01, PC02, PC03, PC04, PC050.3V to 3.6V
Maximum Operating Voltage (VDDCORE, VDDPLL) 1.95V
Maximum Operating Voltage (VDDIO, VDDIN, VDDANA).3.6V
Total DC Output Current on all I/O Pin for TQFP100 package

*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



AT32UC3A

12.2 DC Characteristics

The following characteristics are applicable to the operating temperature range: $T_A = -40^{\circ}$ C to 85°C, unless otherwise specified and are certified for a junction temperature up to $T_J = 100^{\circ}$ C.

Table 12-1.DC Characteristics

Symbol	Parameter	Condition	Min.	Тур.	Мах	Units
V _{VDDCOR} e	DC Supply Core		1.65		1.95	V
V _{VDDPLL}	DC Supply PLL		1.65		1.95	V
V _{VDDIO}	DC Supply Peripheral I/Os		3.0		3.6	V
V_{REF}	Analog reference voltage		2.6		3.6	V
V _{IL}	Input Low-level Voltage		-0.3		+0.8	V
V _{IH}		All GPIOS except for PC00, PC01, PC02, PC03, PC04, PC05.	2.0		5.5V	V
		PC00, PC01, PC02, PC03, PC04, PC05.	2.0		3.6V	V
		I _{OL} =-4mA for PA0-PA20, PB0, PB4-PB9, PB11-PB18, PB24-PB26, PB29-PB31, PX0-PX39			0.4	V
V _{OL}	Output Low-level Voltage	I _{OL} =-8mA for PA21-PA30, PB1-PB3, PB10, PB19-PB23, PB27-PB28, PC0- PC5			0.4	V
V _{OH}	Output High-level Voltage	I _{OH} =4mA for PA0-PA20, PB0, PB4-PB9, PB11-PB18, PB24-PB26, PB29-PB31, PX0-PX39	V _{VDDIO} - 0.4			V
On		I _{OH} =8mA for PA21-PA30, PB1-PB3, PB10, PB19-PB23, PB27-PB28, PC0- PC5	V _{VDDIO} - 0.4			V
I _{OL}		PA0-PA20, PB0, PB4-PB9, PB11-PB18, PB24-PB26, PB29-PB31, PX0-PX39			-4	mA
	Output Low-level Current	PA21-PA30, PB1-PB3, PB10, PB19- PB23, PB27-PB28, PC0-PC5			-8	mA
I _{OH}		PA0-PA20, PB0, PB4-PB9, PB11-PB18, PB24-PB26, PB29-PB31, PX0-PX39			4	mA
	Output High-level Current	PA21-PA30, PB1-PB3, PB10, PB19- PB23, PB27-PB28, PC0-PC5			8	mA
I _{LEAK}	Input Leakage Current	Pullup resistors disabled			1	μA
C _{IN}		TQFP100 Package		7		pF
Input Cap	acitance	LQFP144 Package		7		pF
R _{PULLUP}	Pull-up Resistance	All GPIO and RESET_N pin.	10K	15K		Ohm



12.3 Regulator characteristics

 Table 12-2.
 Electrical characteristics

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
V_{VDDIN}	Supply voltage (input)		3	3.3	3.6	V
V _{VDDOUT}	Supply voltage (output)		1.81	1.85	1.89	V
1	Maximum DC output current with $V_{VDDIN = 3.3V}$				100	mA
OUT	Maximum DC output current with $V_{VDDIN = 2.7V}$				90	mA
I _{SCR}	Static Current of internal regulator	Low Power mode (stop, deep stop or static) at $T_A = 25$ °C		10		μA

Table 12-3.Decoupling requirements

Symbol	Parameter	Condition	Тур.	Techno.	Units
C _{IN1}	Input Regulator Capacitor 1		1	NPO	nF
C _{IN2}	Input Regulator Capacitor 2		4.7	X7R	uF
C _{OUT1}	Output Regulator Capacitor 1		470	NPO	pF
C _{OUT2}	Output Regulator Capacitor 2		2.2	X7R	uF

12.4 Analog characteristics

Table 12-4. Electrical characteristics

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
VADVREF	Analog voltage reference (input)		2.6		3.6	V

Table 12-5.	Decoupling requirements
-------------	-------------------------

Symbol	Parameter	Condition	Тур.	Techno	Units
C _{VREF1}	Voltage reference Capacitor 1		10	-	nF
C _{VREF2}	Voltage reference Capacitor 2		1	-	uF

12.4.1 BOD

Table 12-6.BODLEVEL Values

BODLEVEL Value	Тур.	Тур.	Тур.	Units.
00 0000b	1.40	1.47	1.55	V
01 0111b	1.45	1.52	1.6	V
01 1111b	1.55	1.6	1.65	V
10 0111b	1.65	1.69	1.75	V

The values in Table 12-6 describes the values of the BODLEVEL in the flash FGPFR register.



Table 12-7. BOD Timing

S	Symbol	Parameter	Test Conditions	Тур.	Max.	Units.
Т	Г _{ВОД}	Minimum time with VDDCORE < VBOD to detect power failure	Falling VDDCORE from 1.8V to 1.1V	300	800	ns

12.4.2 POR

Table 12-8. Electrical Characteristic

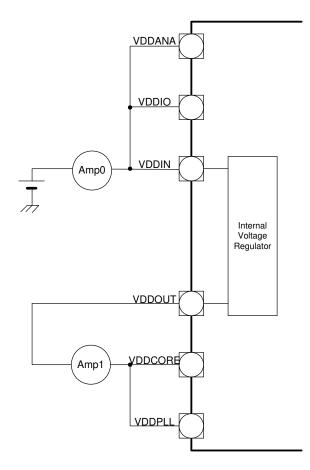
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units.
V _{DDRR}	VDDCORE rise rate to ensure power-on-reset		0.01			V/ms
V _{SSFR}	VDDCORE fall rate to ensure power-on-reset		0.01		400	V/ms
V _{POR+}	Rising threshold voltage: voltage up to which device is kept under reset by POR on rising VDDCORE	Rising VDDCORE: V _{RESTART} -> V _{POR+}	1.35	1.5	1.6	V
V _{POR-}	Falling threshold voltage: voltage when POR resets device on falling VDDCORE	Falling VDDCORE: 1.8V -> V _{POR+}	1.25	1.3	1.4	V
V _{RESTART}	On falling VDDCORE, voltage must go down to this value before supply can rise again to ensure reset signal is released at V_{POR+}	Falling VDDCORE: 1.8V -> V _{RESTART}	-0.1		0.5	V
T _{POR}	Minimum time with VDDCORE < V _{POR} .	Falling VDDCORE: 1.8V -> 1.1V		15		us
T _{RST}	Time for reset signal to be propagated to system			200	400	us

12.5 Power Consumption

The values in Table 12-9 and Table 12-10 on page 46 are measured values of power consumption with operating conditions as follows:

- $\bullet V_{DDIO} = 3.3V$
- • $V_{DDCORE} = V_{DDPLL} = 1.8V$
- •TA = 25° C, TA = 85° C
- •I/Os are configured in input, pull-up enabled.

Figure 12-1. Measurement setup





These figures represent the power consumption measured on the power supplies.

 Table 12-9.
 Power Consumption for Different Modes

Mode	Conditions		Тур.	Unit
	Typ : Ta =25 °C	f = 12 MHz	9	mA
	CPU running from flash ⁽¹⁾ .	f = 24 MHz	15	mA
	VDDIN=3.3 V. VDDCORE =1.8V. CPU clocked from PLL0 at f MHz	f = 36MHz	20	mA
	Voltage regulator is on.	f = 50 MHz	28	mA
Active XIN0 : ext XIN1 stop PLL0 runn All periphe GPIOs on	 XIN0 : external clock. ⁽¹⁾ XIN1 stopped. XIN32 stopped PLL0 running All peripheral clocks activated. GPIOs on internal pull-up. JTAG unconnected with ext pull-up. 	f = 66 MHz	36.3	mA
	Typ : Ta = 25 °C	f = 12 MHz	5	mA
	CPU running from flash ⁽¹⁾ . VDDIN=3.3 V. VDDCORE =1.8V.	f = 24 MHz	10	mA
	CPU clocked from PLL0 at f MHz	f = 36MHz	14	mA
	Voltage regulator is on.	f = 50 MHz	19	mA
Idle XIN0 : external clock. XIN1 stopped. XIN32 stopped PLL0 running All peripheral clocks activated. GPIOs on internal pull-up. JTAG unconnected with ext pull-up.	XIN1 stopped. XIN32 stopped PLL0 running All peripheral clocks activated.	f = 66 MHz	25.5	mA
	Typ : Ta = 25 °C	f = 12 MHz	3	mA
	CPU running from flash ⁽¹⁾ .	f = 24 MHz	6	mA
	CPU clocked from PLL0 at f MHz Voltage regulator is on. XIN0 : external clock.	f = 36MHz	9	mA
Freese		f = 50 MHz	13	mA
Frozen XIN1 stoppe PLL0 runnin All periphera GPIOs on in	XIN1 stopped. XIN32 stopped PLL0 running All peripheral clocks activated. GPIOs on internal pull-up. JTAG unconnected with ext pull-up.	f = 66 MHz	16.8	mA
	Typ : Ta = 25 °C	f = 12 MHz	1	mA
	CPU running from flash ⁽¹⁾ .	f = 24 MHz	2	mA
	CPU clocked from PLL0 at f MHz Voltage regulator is on.	f = 36MHz	3	mA
Standby	XIN0 : external clock.	f = 50 MHz	4	mA
	XIN1 stopped. XIN32 stopped PLL0 running All peripheral clocks activated. GPIOs on internal pull-up. JTAG unconnected with ext pull-up.	f = 66 MHz	4.8	mA



Table 12-9. Power Consumption for Different Modes

Mode	Conditions		Тур.	Unit
	Typ : Ta = 25 °C.	on Amp0	47	uA
Stop	CPU is in stop mode GPIOs on internal pull-up. All peripheral clocks de-activated. DM and DP pins connected to ground. XIN0,Xin1 and XIN2 are stopped	on Amp1	40	uA
	Typ : Ta = 25 °C.CPU is in deepstop mode	on Amp0	36	uA
Deepstop	GPIOs on internal pull-up. All peripheral clocks de-activated. DM and DP pins connected to ground. XIN0,Xin1 and XIN2 are stopped	on Amp1	28	uA
	Typ : Ta = 25 °C. CPU is in static mode	on Amp0	25	uA
Static	GPIOs on internal pull-up. All peripheral clocks de-activated. DM and DP pins connected to ground. XIN0,Xin1 and XIN2 are stopped	on Amp1	14	uA

1. Core frequency is generated from XIN0 using the PLL so that 140 MHz < fpll0 < 160 MHz and 10 MHz < fxin0 < 12MHz

Peripheral	Тур.	Unit
GPIO	37	
SMC	10	
SDRAMC	4	
ADC	18	
EBI	31	
INTC	25	
TWI	14	
MACB	45	
PDCA	30	μA/MHz
PWM	36	
RTC	7	
SPI	13	
SSC	13	
TC	10	
USART	35	
USB	45	

Table 12-10. Power Consumption by Peripheral in Active Mode

12.6 Clock Characteristics

These parameters are given in the following conditions:



- V_{DDCORE} = 1.8V
- Ambient Temperature = 25°C

12.6.1 CPU/HSB Clock Characteristics

Table 12-11. Core Clock Waveform Parameters

Symbol	Parameter	Conditions	Min	Max	Units
1/(t _{CPCPU})	CPU Clock Frequency			66	MHz
t _{CPCPU}	CPU Clock Period		15,15		ns

12.6.2 PBA Clock Characteristics

Table 12-12. PBA Clock Waveform Parameters

Symbol	Parameter	Conditions	Min	Max	Units
1/(t _{CPPBA})	PBA Clock Frequency			66	MHz
t _{CPPBA}	PBA Clock Period		15,15		ns

12.6.3 PBB Clock Characteristics

Table 12-13. PBB Clock Waveform Parameters

Symbol	Parameter	Conditions	Min	Max	Units
1/(t _{CPPBB})	PBB Clock Frequency			66	MHz
t _{CPPBB}	PBB Clock Period		15,15		ns

12.7 Crystal Oscillator Characteristis

The following characteristics are applicable to the operating temperature range: $T_A = -40^{\circ}C$ to 85°C and worst case of power supply, unless otherwise specified.

12.7.1 32 KHz Oscillator Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
1/(t _{CP32KHz})	Crystal Oscillator Frequency				32 768	Hz
CL	Equivalent Load Capacitance		6		12.5	pF
t _{ST}	Startup Time	$C_{L} = 6pF^{(1)}$ $C_{L} = 12.5pF^{(1)}$			600 1200	ms
	Current Concurrention	Active mode			1.8	μA
losc	Current Consumption	Standby mode			0.1	μA

Note: 1. C_L is the equivalent load capacitance.



12.7.2 Main Oscillators Characteristics

 Table 12-15.
 Main Oscillator Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
1/(t _{CPMAIN})	Crystal Oscillator Frequency		0.45		16	MHz
C_{L1}, C_{L2}	Internal Load Capacitance $(C_{L1} = C_{L2})$			12		pF
	Duty Cycle		40	50	60	%
t _{ST}	Startup Time				TBD	ms
A // L)	VIN Cleak Fragmanau	External clock			50	MHz
1/(t _{CPXIN})	XIN Clock Frequency	Crystal	0.45		16	MHz
t _{CHXIN}	XIN Clock High Half-period		0.4 x t _{CPXIN}		0.6 x t _{CPXIN}	
t _{CLXIN}	XIN Clock Low Half-period		0.4 x t _{CPXIN}		0.6 x t _{CPXIN}	
C _{IN}	XIN Input Capacitance			7		pF

12.7.3 PLL Characteristics

Table 12-16. Phase Lock Loop Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
F _{OUT}	Output Frequency		80		240	MHz
F _{IN}	Input Frequency		4		16	MHz
	Current Consumption	active mode (Fout=80Mhz)		250		μA
	Current Consumption	active mode (Fout=240Mhz)		600		μA



12.8 ADC Characteristics

Table 12-17.	Channel Conversion Time and ADC Clock

Parameter	Conditions	Min	Тур	Max	Units
ADC Clock Frequency	10-bit resolution mode			5	MHz
ADC Clock Frequency	8-bit resolution mode			8	MHz
Startup Time	Return from Idle Mode			20	μs
Track and Hold Acquisition Time		600			ns
Conversion Time	ADC Clock = 5 MHz			2	μs
Conversion Time	ADC Clock = 8 MHz			1.25	μs
Throughput Rate	ADC Clock = 5 MHz			384 ⁽¹⁾	kSPS
Throughput Rate	ADC Clock = 8 MHz			533 ⁽²⁾	kSPS

Notes: 1. Corresponds to 13 clock cycles at 5 MHz: 3 clock cycles for track and hold acquisition time and 10 clock cycles for conversion.

2. Corresponds to 15 clock cycles at 8 MHz: 5 clock cycles for track and hold acquisition time and 10 clock cycles for conversion.

Table 12-18. External Voltage Reference Input

Parameter	Conditions	Min	Тур	Max	Units
ADVREF Input Voltage Range		2.6		VDDANA	V
ADVREF Average Current	On 13 samples with ADC Clock = 5 MHz		200	250	μA
Current Consumption on VDDANA				1.25	mA

Note: ADVREF should be connected to GND to avoid extra consumption in case ADC is not used.

Table 12-19. Analog Inputs

Parameter	Min	Тур	Max	Units
Input Voltage Range	0		VADVREF	
Input Leakage Current			1	μA
Input Capacitance		17		pF

Table 12-20. Transfer Characteristics in 8-bit mode

Parameter	Conditions	Min	Тур	Max	Units
Resolution			8		Bit
	f=5MHz			0.8	LSB
Absolute Accuracy	f=8MHz			1.5	LSB
Integral Non-linearity	f=5MHz		0.35	0.5	LSB
	f=8MHz		0.5	1.0	LSB
Differential Non-linearity	f=5MHz		0.3	0.5	LSB
	f=8MHz		0.5	1.0	LSB
Offset Error	f=5MHz	-0.5		0.5	LSB
Gain Error	f=5MHz	-0.5		0.5	LSB



Table 12-21.	Transfer	Characteristics	in	10-bit mode
--------------	----------	-----------------	----	-------------

Parameter	Conditions	Min	Тур	Max	Units
Resolution			10		Bit
Absolute Accuracy	f=5MHz			3	LSB
Integral Non-linearity	f=5MHz		1.5	2	LSB
Differential New View anti-	f=5MHz		1	2	LSB
Differential Non-linearity	f=2.5MHz		0.6	1	LSB
Offset Error	f=5MHz	-2		2	LSB
Gain Error	f=5MHz	-2		2	LSB



12.9 EBI Timings

These timings are given for worst case process, T = 85·C, VDDCORE = 1.65V, VDDIO = 3V and 40 pF load capacitance.

Symbol	Parameter	Max ⁽¹⁾	Units
1/(t _{CPSMC})	SMC Controller Clock Frequency	1/(t _{cpcpu})	MHz

Note: 1. The maximum frequency of the SMC interface is the same as the max frequency for the HSB.

Table 12-23. SMC Read Signals with Hold Settings

Symbol	Parameter	Min	Units
	NRD C	ontrolled (READ_MODE = 1)	
SMC ₁	Data Setup before NRD High	12	
SMC ₂	Data Hold after NRD High	0	
SMC ₃	NRD High to NBS0/A0 Change ⁽¹⁾	nrd hold length * t _{CPSMC} - 1.3	
SMC ₄	NRD High to NBS1 Change ⁽¹⁾	nrd hold length * t _{CPSMC} - 1.3	
SMC ₅	NRD High to NBS2/A1 Change ⁽¹⁾	nrd hold length * t _{CPSMC} - 1.3	ns
SMC ₆	NRD High to NBS3 Change ⁽¹⁾	nrd hold length * t _{CPSMC} - 1.3	
SMC ₇	NRD High to A2 - A25 Change ⁽¹⁾	nrd hold length * t _{CPSMC} - 1.3	
SMC ₈	NRD High to NCS Inactive ⁽¹⁾	(nrd hold length - ncs rd hold length) * t_{CPSMC} - 2.3	
SMC ₉	NRD Pulse Width	nrd pulse length * t _{CPSMC} - 1.4	
	NRD C	ontrolled (READ_MODE = 0)	
SMC ₁₀	Data Setup before NCS High	11.5	
SMC ₁₁	Data Hold after NCS High	0	
SMC ₁₂	NCS High to NBS0/A0 Change ⁽¹⁾	ncs rd hold length * t _{CPSMC} - 2.3	
SMC ₁₃	NCS High to NBS0/A0 Change ⁽¹⁾	ncs rd hold length * t _{CPSMC} - 2.3	
SMC ₁₄	NCS High to NBS2/A1 Change ⁽¹⁾	ncs rd hold length * t _{CPSMC} - 2.3	ns
SMC ₁₅	NCS High to NBS3 Change ⁽¹⁾	ncs rd hold length * t _{CPSMC} - 2.3	
SMC ₁₆	NCS High to A2 - A25 Change ⁽¹⁾	ncs rd hold length * t _{CPSMC} - 4	
SMC ₁₇	NCS High to NRD Inactive ⁽¹⁾	ncs rd hold length - nrd hold length)* t _{CPSMC} - 1.3	
SMC ₁₈	NCS Pulse Width	ncs rd pulse length * t _{CPSMC} - 3.6	

Note: 1. hold length = total cycle duration - setup duration - pulse duration. "hold length" is for "ncs rd hold length" or "nrd hold length".



Symbol	Parameter	Min	Units		
NRD Controlled (READ_MODE = 1)					
SMC ₁₉	Data Setup before NRD High	13.7			
SMC ₂₀	Data Hold after NRD High	1	ns		
	NRD Controlled (READ_MODE = 0)				
SMC ₂₁	Data Setup before NCS High	13.3			
SMC ₂₂	Data Hold after NCS High	0	ns		

Table 12-24. SMC Read Signals with no Hold Settings

Table 12-25. SMC Write Signals with Hold Settings

Symbol	Parameter	Min	Units	
NRD Controlled (READ_MODE = 1)				
SMC ₂₃	Data Out Valid before NWE High	(nwe pulse length - 1) * t _{CPSMC} - 0.9		
SMC ₂₄	Data Out Valid after NWE High ⁽¹⁾	nwe hold length * t _{CPSMC} - 6		
SMC ₂₅	NWE High to NBS0/A0 Change ⁽¹⁾	nwe hold length * t _{CPSMC} - 1.9		
SMC ₂₆	NWE High to NBS1 Change ⁽¹⁾	nwe hold length * t _{CPSMC} - 1.9		
SMC ₂₉	NWE High to NBS2/A1 Change ⁽¹⁾	nwe hold length * t _{CPSMC} - 1.9	ns	
SMC ₃₀	NWE High to NBS3 Change ⁽¹⁾	nwe hold length * t _{CPSMC} - 1.9		
SMC ₃₁	NWE High to A2 - A25 Change ⁽¹⁾	nwe hold length * t _{CPSMC} - 1.7		
SMC ₃₂	NWE High to NCS Inactive ⁽¹⁾	(nwe hold length - ncs wr hold length)* t _{CPSMC} - 2.9		
SMC ₃₃	NWE Pulse Width	nwe pulse length * t _{CPSMC} - 0.9		
	NRD C	controlled (READ_MODE = 0)	U	
SMC ₃₄	Data Out Valid before NCS High	(ncs wr pulse length - 1)* t _{CPSMC} - 4.6		
SMC ₃₅	Data Out Valid after NCS High ⁽¹⁾	ncs wr hold length * t _{CPSMC} - 5.8	ns	
SMC ₃₆	NCS High to NWE Inactive ⁽¹⁾	(ncs wr hold length - nwe hold length)* t _{CPSMC} - 0.6		

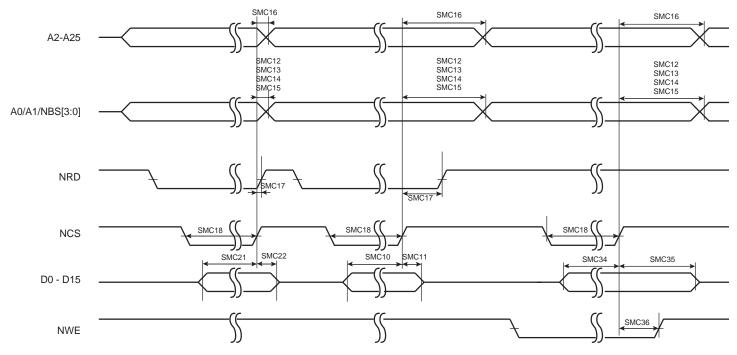
Note: 1. hold length = total cycle duration - setup duration - pulse duration. "hold length" is for "ncs wr hold length" or "nwe hold length"



Symbol	Parameter	Min	Units
SMC ₃₇	NWE Rising to A2-A25 Valid	5.4	
SMC ₃₈	NWE Rising to NBS0/A0 Valid	5	
SMC ₃₉	NWE Rising to NBS1 Change	5	
SMC ₄₀	NWE Rising to A1/NBS2 Change	5	
SMC ₄₁	NWE Rising to NBS3 Change	5	ns
SMC ₄₂	NWE Rising to NCS Rising	5.1	
SMC ₄₃	Data Out Valid before NWE Rising	(nwe pulse length - 1) * t _{CPSMC} - 1.2	
SMC ₄₄	Data Out Valid after NWE Rising	5	
SMC ₄₅	NWE Pulse Width	nwe pulse length * t _{CPSMC} - 0.9	

Table 12-26. SMC Write Signals with No Hold Settings (NWE Controlled only).

Figure 12-2. SMC Signals for NCS Controlled Accesses.





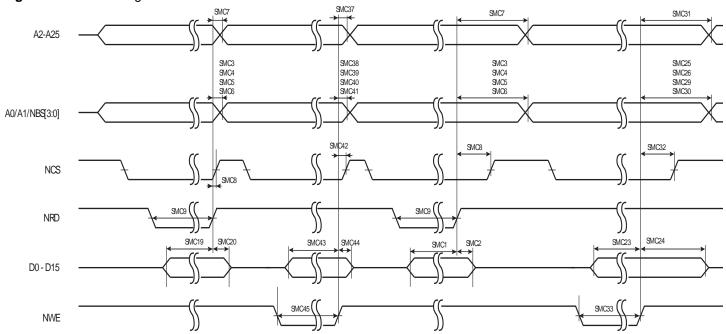


Figure 12-3. SMC Signals for NRD and NRW Controlled Accesses.

12.9.1 SDRAM Signals

These timings are given for 10 pF load on SDCK and 40 pF on other signals.

Table 12-27.	SDRAM Clock Signal.
--------------	---------------------

Symbol	Parameter	Max ⁽¹⁾	Units
1/(t _{CPSDCK})	SDRAM Controller Clock Frequency	1/(t _{cpcpu})	MHz

Note: 1. The maximum frequency of the SDRAMC interface is the same as the max frequency for the HSB.

Table 12-28. SDRAM Clock Signal.

Symbol	Parameter	Min	Units
SDRAMC ₁	SDCKE High before SDCK Rising Edge	7.4	ns
SDRAMC ₂	SDCKE Low after SDCK Rising Edge	3.2	
SDRAMC ₃	SDCKE Low before SDCK Rising Edge	7	
SDRAMC ₄	SDCKE High after SDCK Rising Edge	2.9	
SDRAMC ₅	SDCS Low before SDCK Rising Edge	7.5	
SDRAMC ₆	SDCS High after SDCK Rising Edge	1.6	
SDRAMC ₇	RAS Low before SDCK Rising Edge	7.2	
SDRAMC ₈	RAS High after SDCK Rising Edge	2.3	
SDRAMC ₉	SDA10 Change before SDCK Rising Edge	7.6	
SDRAMC ₁₀	SDA10 Change after SDCK Rising Edge	1.9	



Symbol	Parameter	Min	Units
SDRAMC ₁₁	Address Change before SDCK Rising Edge	6.2	
SDRAMC ₁₂	Address Change after SDCK Rising Edge	2.2	
SDRAMC ₁₃	Bank Change before SDCK Rising Edge	6.3	
SDRAMC ₁₄	Bank Change after SDCK Rising Edge	2.4	
SDRAMC ₁₅	CAS Low before SDCK Rising Edge	7.4	
SDRAMC ₁₆	CAS High after SDCK Rising Edge	1.9	
SDRAMC ₁₇	DQM Change before SDCK Rising Edge	6.4	
SDRAMC ₁₈	DQM Change after SDCK Rising Edge	2.2	ns
SDRAMC ₁₉	D0-D15 in Setup before SDCK Rising Edge	9	
SDRAMC ₂₀	D0-D15 in Hold after SDCK Rising Edge	0	
SDRAMC ₂₃	SDWE Low before SDCK Rising Edge	7.6	
SDRAMC ₂₄	SDWE High after SDCK Rising Edge	1.8	
SDRAMC ₂₅	D0-D15 Out Valid before SDCK Rising Edge	7.1	
SDRAMC ₂₆	D0-D15 Out Valid after SDCK Rising Edge	1.5	1

Table 12-28.	SDRAM	Clock	Signal.
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AT32UC3A

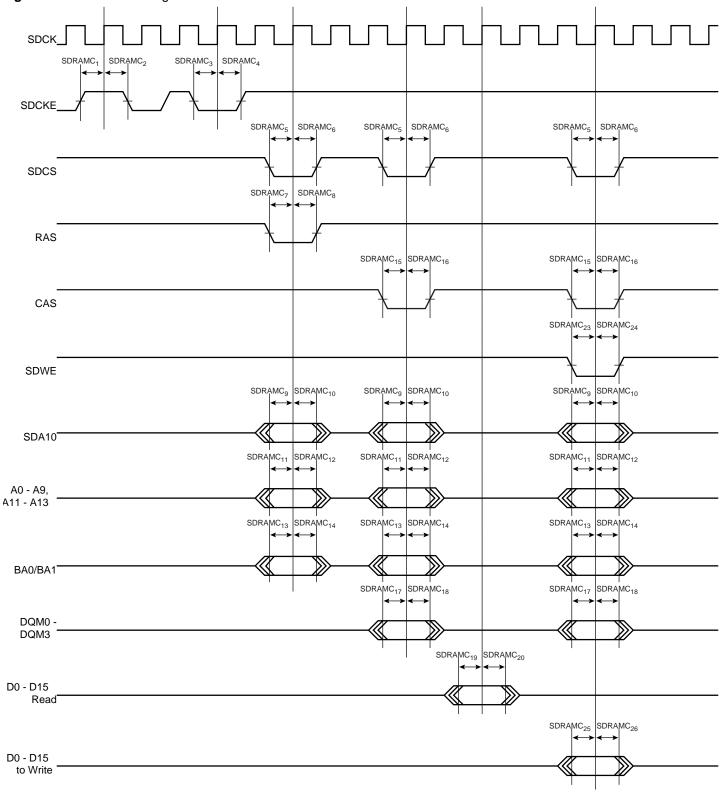


Figure 12-4. SDRAMC Signals relative to SDCK.



12.10 JTAG Timings

12.10.1 JTAG Interface Signals

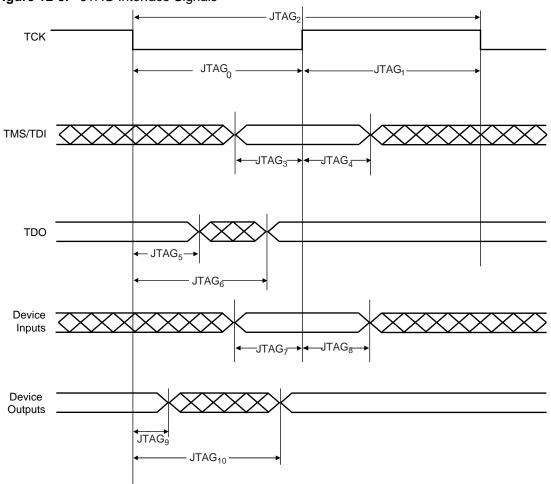
Table 12-29. JTAG Interface Timing specification

Symbol	Parameter	Conditions	Min	Max	Units
JTAG ₀	TCK Low Half-period	(1)	6		ns
JTAG ₁	TCK High Half-period	(1)	3		ns
JTAG ₂	TCK Period	(1)	9		ns
JTAG ₃	TDI, TMS Setup before TCK High	(1)	1		ns
JTAG ₄	TDI, TMS Hold after TCK High	(1)	0		ns
JTAG ₅	TDO Hold Time	(1)	4		ns
JTAG ₆	TCK Low to TDO Valid	(1)		6	ns
JTAG ₇	Device Inputs Setup Time	(1)			ns
JTAG ₈	Device Inputs Hold Time	(1)			ns
JTAG ₉	Device Outputs Hold Time	(1)			ns
JTAG ₁₀	TCK to Device Outputs Valid	(1)			ns

Note: 1. V_{VDDIO} from 3.0V to 3.6V, maximum external capacitor = 40pF

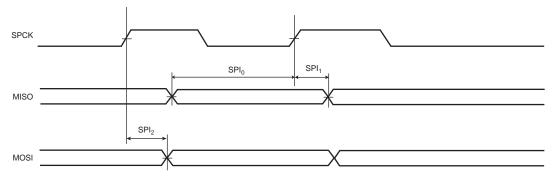






12.11 SPI Characteristics







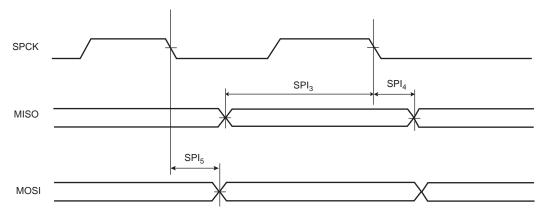
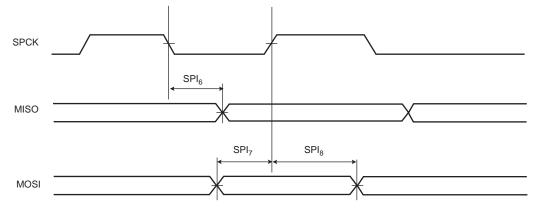


Figure 12-7. SPI Master mode with (CPOL=0 and NCPHA=1) or (CPOL=1 and NCPHA=0)

Figure 12-8. SPI Slave mode with (CPOL=0 and NCPHA=1) or (CPOL=1 and NCPHA=0)





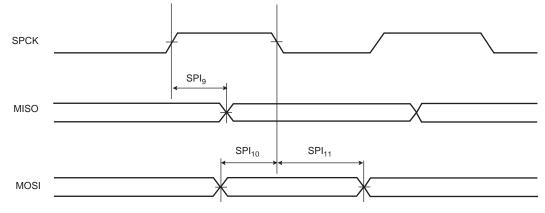




Table 12-30. SPI Timings

Symbol	Parameter	Conditions	Min	Max	Units
SPI0	MISO Setup time before SPCK rises (master)	3.3V domain ⁽¹⁾	$22 + (t_{CPMCK})/2^{(2)}$		ns
SPI ₁	MISO Hold time after SPCK rises (master)	3.3V domain ⁽¹⁾	0		ns
SPI ₂	SPCK rising to MOSI Delay (master)	3.3V domain ⁽¹⁾		7	ns
SPI ₃	MISO Setup time before SPCK falls (master)	3.3V domain ⁽¹⁾	$22 + (t_{CPMCK})/2^{(2)}$		ns
SPI4	MISO Hold time after SPCK falls (master)	3.3V domain ⁽¹⁾	0		ns
SPI ₅	SPCK falling to MOSI Delay (master)	3.3V domain ⁽¹⁾		7	ns
SPI ₆	SPCK falling to MISO Delay (slave)	3.3V domain ⁽¹⁾		26.5	ns
SPI7	MOSI Setup time before SPCK rises (slave)	3.3V domain ⁽¹⁾	0		ns
SPI ₈	MOSI Hold time after SPCK rises (slave)	3.3V domain ⁽¹⁾	1.5		ns
SPI ₉	SPCK rising to MISO Delay (slave)	3.3V domain ⁽¹⁾		27	ns
SPI ₁₀	MOSI Setup time before SPCK falls (slave)	3.3V domain ⁽¹⁾	0		ns
SPI ₁₁	MOSI Hold time after SPCK falls (slave)	3.3V domain ⁽¹⁾	1		ns

Notes: 1. 3.3V domain: V_{VDDIO} from 3.0V to 3.6V, maximum external capacitor = 40 pF.

2. t_{CPMCK} : Master Clock period in ns.

12.12 MACB Characteristics

Table 12-31. Ethernet MAC Signals

Symbol	Parameter	Conditions	Min (ns)	Max (ns)
EMAC ₁	Setup for EMDIO from EMDC rising	Load: 20pF ⁽²⁾		
EMAC ₂	Hold for EMDIO from EMDC rising	Load: 20pF ⁽²⁾		
EMAC ₃	EMDIO toggling from EMDC falling	Load: 20pF ⁽²⁾		

Notes: 1. f: MCK frequency (MHz)

2. V_{VDDIO} from 3.0V to 3.6V, maximum external capacitor = 20 pF

Table 12-32. Ethernet MAC MII Specific Signals

Symbol	Parameter	Conditions	Min (ns)	Max (ns)
EMAC ₄	Setup for ECOL from ETXCK rising	Load: 20pF ⁽¹⁾	3	
EMAC ₅	Hold for ECOL from ETXCK rising	Load: 20pF ⁽¹⁾	0	
EMAC ₆	Setup for ECRS from ETXCK rising	Load: 20pF ⁽¹⁾	3	
EMAC ₇	Hold for ECRS from ETXCK rising	Load: 20pF ⁽¹⁾	0	
EMAC ₈	ETXER toggling from ETXCK rising	Load: 20pF ⁽¹⁾		15
EMAC ₉	ETXEN toggling from ETXCK rising	Load: 20pF ⁽¹⁾		15
EMAC ₁₀	ETX toggling from ETXCK rising	Load: 20pF ⁽¹⁾		15
EMAC ₁₁	Setup for ERX from ERXCK	Load: 20pF ⁽¹⁾	1	



Table 12-32. Ethernet MAC MII Specific Signals

Symbol	Parameter	Conditions	Min (ns)	Max (ns)
EMAC ₁₂	Hold for ERX from ERXCK	Load: 20pF ⁽¹⁾	1.5	
EMAC ₁₃	Setup for ERXER from ERXCK	Load: 20pF ⁽¹⁾	1	
EMAC ₁₄	Hold for ERXER from ERXCK	Load: 20pF ⁽¹⁾	0.5	
EMAC ₁₅	Setup for ERXDV from ERXCK	Load: 20pF ⁽¹⁾	1.5	
EMAC ₁₆	Hold for ERXDV from ERXCK	Load: 20pF ⁽¹⁾	1	

Note: 1. V_{VDDIO} from 3.0V to 3.6V, maximum external capacitor = 20 pF

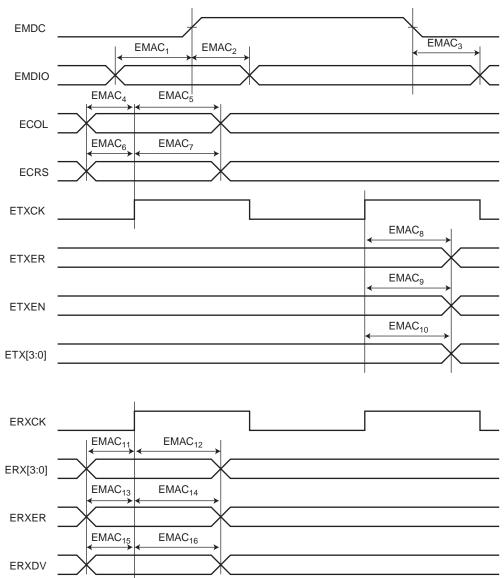


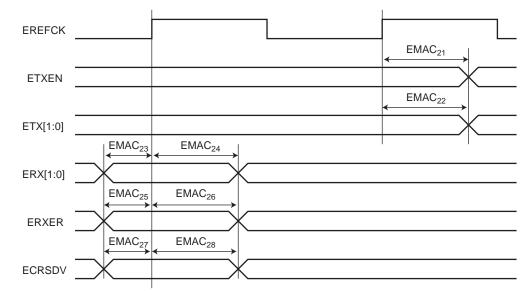
Figure 12-10. Ethernet MAC MII Mode



Symbol	Parameter	Min (ns)	Max (ns)
EMAC ₂₁	ETXEN toggling from EREFCK rising	7	14.5
EMAC ₂₂	ETX toggling from EREFCK rising	7	14.7
EMAC ₂₃	Setup for ERX from EREFCK	1.5	
EMAC ₂₄	Hold for ERX from EREFCK	0	
EMAC ₂₅	Setup for ERXER from EREFCK	1.5	
EMAC ₂₆	Hold for ERXER from EREFCK	0	
EMAC ₂₇	Setup for ECRSDV from EREFCK	1.5	
EMAC ₂₈	Hold for ECRSDV from EREFCK	0	

Table 12-33. Ethernet MAC RMII Specific Signals

Figure 12-11. Ethernet MAC RMII Mode



12.13 Flash Characteristics

The following table gives the device maximum operating frequency depending on the field FWS of the Flash FSR register. This field defines the number of wait states required to access the Flash Memory.

FWS	Read Operations Maximum Operating Frequency (MHz)	
0	1 cycle	33
1	2 cycles	66



Table 12-35.Programming Time

Temperature Operating Range Part	Page Programming Time (ms)	Chip Erase Time (ms)
Industrial	4	4
Automotive	16	16



13. Mechanical Characteristics

13.1 Thermal Considerations

13.1.1 Thermal Data

Table 13-1 summarizes the thermal resistance data depending on the package.

Symbol	Parameter	Condition	Package	Тур	Unit
θ_{JA}	Junction-to-ambient thermal resistance	Still Air	TQFP100	43.4	·C/W
θ _{JC}	Junction-to-case thermal resistance		TQFP100	5.5	·C/vv
θ_{JA}	Junction-to-ambient thermal resistance	Still Air	LQFP144	39.8	CAN
θ _{JC}	Junction-to-case thermal resistance		LQFP144	8.9	·C/W

 Table 13-1.
 Thermal Resistance Data

13.1.2 Junction Temperature

The average chip-junction temperature, T_J , in °C can be obtained from the following:

1.
$$T_J = T_A + (P_D \times \theta_{JA})$$

2. $T_J = T_A + (P_D \times (\theta_{HEATSINK} + \theta_{JC}))$

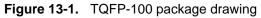
where:

- θ_{JA} = package thermal resistance, Junction-to-ambient (°C/W), provided in Table 13-1 on page 64.
- θ_{JC} = package thermal resistance, Junction-to-case thermal resistance (°C/W), provided in Table 13-1 on page 64.
- $\theta_{HEAT SINK}$ = cooling device thermal resistance (°C/W), provided in the device datasheet.
- P_D = device power consumption (W) estimated from data provided in the section "Power Consumption" on page 44.
- T_A = ambient temperature (°C).

From the first equation, the user can derive the estimated lifetime of the chip and decide if a cooling device is necessary or not. If a cooling device is to be fitted on the chip, the second equation should be used to compute the resulting average chip-junction temperature T_J in °C.



13.2 Package Drawings



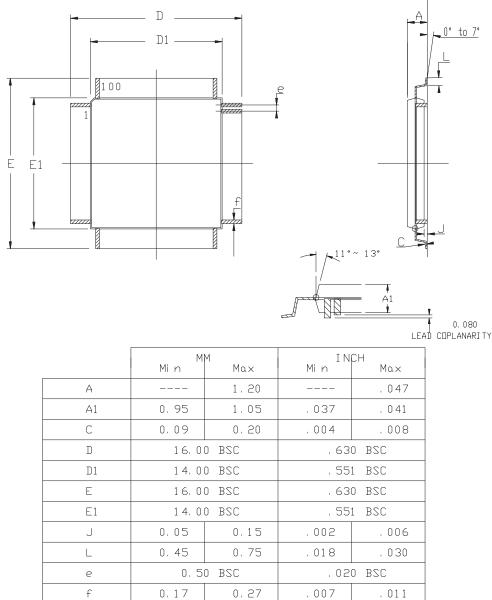


Table 13-2. Device and Package Maximum Weight

500 mg

Table 13-3. Package Characteristics

Moisture Sensitivity Level	Jdec J-STD0-20D - MSL 3
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Table 13-4.Package Reference

JEDEC Drawing Reference	MS-026
JESD97 Classification	E3



Figure 13-2. LQFP-144 package drawing

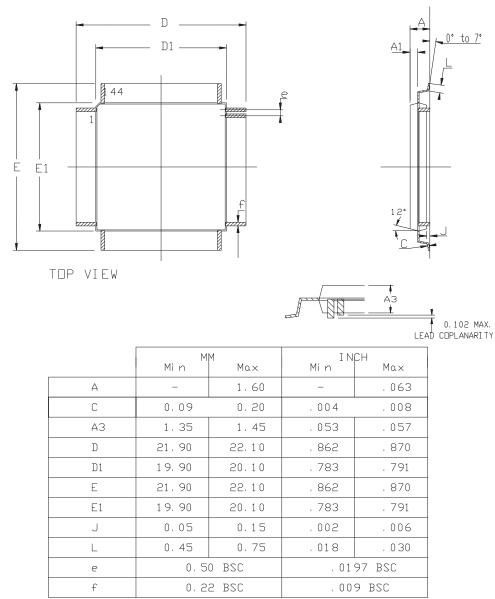


Table 13-5. Device and Package Maximum Weight

		1300	mg
--	--	------	----

Table 13-6.Package Characteristics

Moisture Sensitivity Level Jdec J-STD0-20D - MSL	3
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Table 13-7. Package Reference

JEDEC Drawing Reference	MS-026
JESD97 Classification	E3



AT32UC3A

Figure 13-3. FFBGA-144 package drawing

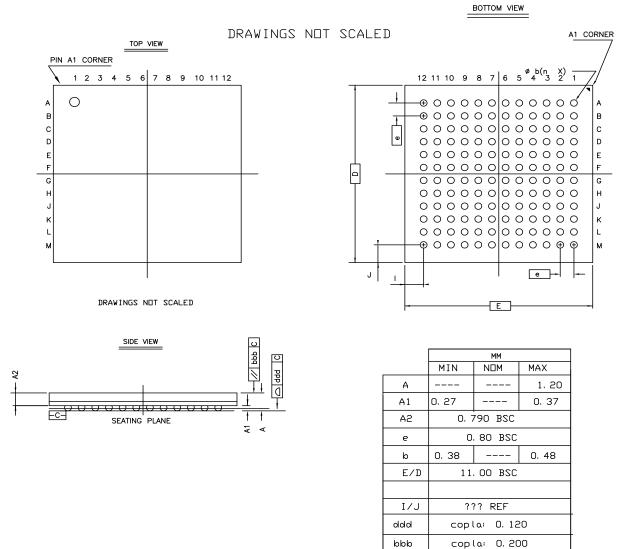


Table 13-8.	Device and Package Maximum Weight
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	1300	mg
_		

Table 13-9. Package Characteristics

Moisture Sensitivity Level MSL3

Table 13-10. Package Reference

JEDEC Drawing Reference	MS-026
JESD97 Classification	E3



13.3 Soldering Profile

Table 13-11 gives the recommended soldering profile from J-STD-20.

Profile Feature	Green Package
Average Ramp-up Rate (217°C to Peak)	3°C/sec
Preheat Temperature 175°C ±25°C	Min. 150 °C, Max. 200 °C
Time Maintained Above 217°C	60-150 sec
Time within 5.C of Actual Peak Temperature	30 sec
Peak Temperature Range	260 °C
Ramp-down Rate	6 °C/sec
Time 25 C to Peak Temperature	Max. 8 minutes

Note: It is recommended to apply a soldering temperature higher than 250°C. A maximum of three reflow passes is allowed per component.



14. Ordering Information

 Table 14-1.
 Ordering Information

Device	Ordering Code	Package	Conditioning	Temperature Operating Range
AT32UC3A0512	AT32UC3A0512-ALUT	144 LQFP	Tray	Industrial (-40·C to 85·C)
	AT32UC3A0512-ALUR	144 LQFP	Reel	Industrial (-40·C to 85·C)
	AT32UC3A0512-ALTR	144 LQFP	Reel	Automotive (-40·C to 85·C)
	AT32UC3A0512-ALTT	144 LQFP	Tray	Automotive (-40·C to 85·C)
	AT32UC3A0512-ALTES	144 LQFP	Tray	Automotive (-40·C to 85·C) samples
	AT32UC3A0512-CTUT	144 FFBGA	Tray	Industrial (-40·C to 85·C)
	AT32UC3A0512-CTUR	144 FFBGA	Reel	Industrial (-40·C to 85·C)
AT32UC3A0256	AT32UC3A0256-ALUT	144 LQFP	Tray	Industrial (-40·C to 85·C)
	AT32UC3A0256-ALUR	144 LQFP	Reel	Industrial (-40·C to 85·C)
	AT32UC3A0256-CTUT	144 FFBGA	Tray	Industrial (-40·C to 85·C)
	AT32UC3A0256-CTUR	144 FFBGA	Reel	Industrial (-40·C to 85·C)
AT32UC3A0128	AT32UC3A0128-ALUT	144 LQFP	Tray	Industrial (-40·C to 85·C)
	AT32UC3A0128-ALUR	144 LQFP	Reel	Industrial (-40·C to 85·C)
	AT32UC3A0128-CTUT	144 FFBGA	Tray	Industrial (-40·C to 85·C)
	AT32UC3A0128-CTUR	144 FFBGA	Reel	Industrial (-40·C to 85·C)
AT32UC3A1512	AT32UC3A1512-AUT	100 TQFP	Tray	Industrial (-40·C to 85·C)
	AT32UC3A1512-AUR	100 TQFP	Reel	Industrial (-40·C to 85·C)
AT32UC3A1256	AT32UC3A1256-AUT	100 TQFP	Tray	Industrial (-40·C to 85·C)
	AT32UC3A1256-AUR	100 TQFP	Reel	Industrial (-40·C to 85·C)
AT32UC3A1128	AT32UC3A1128-AUT	100 TQFP	Tray	Industrial (-40·C to 85·C)
	AT32UC3A1128-AUR	100 TQFP	Reel	Industrial (-40·C to 85·C)

14.1 Automotive Quality Grade

The AT32UC3A have been developed and manufactured according to the most stringent requirements of the international standard ISO-TS-16949. This data sheet will contain limit values extracted from the results of extensive characterization (Temperature and Voltage). The quality and reliability of the AT32UC3A is verified during regular product qualification as per AEC-Q100 grade 3.

As indicated in the ordering information paragraph, the product is available in only one temperature grade T: $-40^{\circ}C / + 85^{\circ}C$.



15. Errata

All industrial parts labelled with -UES (engineering samples) are revision E parts.

15.1 Rev. K, L, M

15.1.1 PWM

1. PWM channel interrupt enabling triggers an interrupt

When enabling a PWM channel that is configured with center aligned period (CALG=1), an interrupt is signalled.

Fix/Workaround

When using center aligned mode, enable the channel and read the status before channel interrupt is enabled.

2. PWM counter restarts at 0x0001

The PWM counter restarts at 0x0001 and not 0x0000 as specified. Because of this the first PWM period has one more clock cycle.

Fix/Workaround

- The first period is 0x0000, 0x0001, ..., period
- Consecutive periods are 0x0001, 0x0002, ..., period

3. PWM update period to a 0 value does not work

It is impossible to update a period equal to 0 by the using the PWM update register (PWM_CUPD).

Fix/Workaround

Do not update the PWM_CUPD register with a value equal to 0.

15.1.2 ADC

1. Sleep Mode activation needs additional A to D conversion

If the ADC sleep mode is activated when the ADC is idle the ADC will not enter sleep mode before after the next AD conversion.

Fix/Workaround

Activate the sleep mode in the mode register and then perform an AD conversion.

15.1.3 SPI

1. SPI Slave / PDCA transfer: no TX UNDERRUN flag

There is no TX UNDERRUN flag available, therefore in SPI slave mode, there is no way to be informed of a character lost in transmission.

Fix/Workaround

For PDCA transfer: none.

2. SPI FDIV option does not work

Selecting clock signal using FDIV = 1 does not work as specified.

Fix/Workaround

Do not set FDIV = 1.



3. SPI Bad Serial Clock Generation on 2nd chip_select when SCBR = 1, CPOL=1 and NCPHA=0

When multiple CS are in use, if one of the baudrate equals to 1 and one of the others doesn't equal to 1, and CPOL=1 and CPHA=0, then an aditional pulse will be generated on SCK. **Fix/workaround**

When multiple CS are in use, if one of the baudrate equals 1, the other must also equal 1 if CPOL=1 and CPHA=0.

4. SPI Glitch on RXREADY flag in slave mode when enabling the SPI or during the first transfer

In slave mode, the SPI can generate a false RXREADY signal during enabling of the SPI or during the first transfer.

Fix/Workaround

1. Set slave mode, set required CPOL/CPHA.

- 2. Enable SPI.
- 3. Set the polarity CPOL of the line in the opposite value of the required one.
- 4. Set the polarity CPOL to the required one.
- 5. Read the RXHOLDING register.

Transfers can now befin and RXREADY will now behave as expected.

 SPI Disable does not work in Slave mode Fix/workaround Read the last received data then perform a Software reset.

15.1.4 Power Manager

If the BOD level is higher than VDDCORE, the part is constantly under reset
 If the BOD level is set to a value higher than VDDCORE and enabled by fuses, the part will
 be in constant reset.

Fix/Workaround

Apply an external voltage on VDDCORE that is higher than the BOD level and is lower than VDDCORE max and disable the BOD.

- 15.1.5 PDCA
- 1. Wrong PDCA behavior when using two PDCA channels with the same PID. Fix/Workaround

The same PID should not be assigned to more than one channel.

15.1.6 TWI

1. The TWI RXRDY flag in SR register is not reset when a software reset is performed. Fix/Workaround

After a Software Reset, the register TWI RHR must be read.

- 15.1.7 USART
- ISO7816 info register US_NER cannot be read The NER register always returns zero.
 Fix/Workaround None

15.1.8 Processor and Architecture

1. LDM instruction with PC in the register list and without ++ increments Rp



For LDM with PC in the register list: the instruction behaves as if the ++ field is always set, ie the pointer is always updated. This happens even if the ++ field is cleared. Specifically, the increment of the pointer is done in parallel with the testing of R12. **Fix/Workaround** None.



15.2 Rev. J

15.2.1 PWM

1. PWM channel interrupt enabling triggers an interrupt

When enabling a PWM channel that is configured with center aligned period (CALG=1), an interrupt is signalled.

Fix/Workaround

When using center aligned mode, enable the channel and read the status before channel interrupt is enabled.

2. PWM counter restarts at 0x0001

The PWM counter restarts at 0x0001 and not 0x0000 as specified. Because of this the first PWM period has one more clock cycle.

Fix/Workaround

- The first period is 0x0000, 0x0001, ..., period
- Consecutive periods are 0x0001, 0x0002, ..., period

3. PWM update period to a 0 value does not work

It is impossible to update a period equal to 0 by the using the PWM update register (PWM_CUPD).

Fix/Workaround

Do not update the PWM_CUPD register with a value equal to 0.

15.2.2 ADC

1. Sleep Mode activation needs additional A to D conversion

If the ADC sleep mode is activated when the ADC is idle the ADC will not enter sleep mode before after the next AD conversion.

Fix/Workaround

Activate the sleep mode in the mode register and then perform an AD conversion.

15.2.3 SPI

1. SPI Slave / PDCA transfer: no TX UNDERRUN flag

There is no TX UNDERRUN flag available, therefore in SPI slave mode, there is no way to be informed of a character lost in transmission.

Fix/Workaround

For PDCA transfer: none.

2. SPI FDIV option does not work

Selecting clock signal using FDIV = 1 does not work as specified.

Fix/Workaround

Do not set FDIV = 1.

3. SPI Bad Serial Clock Generation on 2nd chip_select when SCBR = 1, CPOL=1 and NCPHA=0

When multiple CS are in use, if one of the baudrate equals to 1 and one of the others doesn't equal to 1, and CPOL=1 and CPHA=0, then an aditional pulse will be generated on SCK. **Fix/workaround**



When multiple CS are in use, if one of the baudrate equals 1, the other must also equal 1 if CPOL=1 and CPHA=0.

4. SPI Glitch on RXREADY flag in slave mode when enabling the SPI or during the first transfer

In slave mode, the SPI can generate a false RXREADY signal during enabling of the SPI or during the first transfer.

Fix/Workaround

- 1. Set slave mode, set required CPOL/CPHA.
- 2. Enable SPI.
- 3. Set the polarity CPOL of the line in the opposite value of the required one.
- 4. Set the polarity CPOL to the required one.
- 5. Read the RXHOLDING register.

Transfers can now befin and RXREADY will now behave as expected.

5. SPI Disable does not work in Slave mode Fix/workaround

Read the last received data then perform a Software reset.

15.2.4 Power Manager

1.	If the BOD level is higher than VDDCORE, the part is constantly under reset
	If the BOD level is set to a value higher than VDDCORE and enabled by fuses, the part will
	be in constant reset.

Fix/Workaround

Apply an external voltage on VDDCORE that is higher than the BOD level and is lower than VDDCORE max and disable the BOD.

15.2.5 PDCA

1. Wrong PDCA behavior when using two PDCA channels with the same PID. Fix/Workaround

The same PID should not be assigned to more than one channel.

- 15.2.6 TWI
- 1. The TWI RXRDY flag in SR register is not reset when a software reset is performed. Fix/Workaround

After a Software Reset, the register TWI RHR must be read.

15.2.7 SDRAMC

1. Code execution from external SDRAM does not work Code execution from SDRAM does not work.

Fix/Workaround

Do not run code from SDRAM.

15.2.8 GPIO

 PA29 (TWI SDA) and PA30 (TWI SCL) GPIO VIH (input high voltage) is 3.6V max instead of 5V tolerant The following GPIOs are not 5V tolerant : PA29 and PA30. Fix/Workaround



None.

15.2.9 USART

 ISO7816 info register US_NER cannot be read The NER register always returns zero.
 Fix/Workaround None

15.2.10 Processor and Architecture

1. LDM instruction with PC in the register list and without ++ increments Rp

For LDM with PC in the register list: the instruction behaves as if the ++ field is always set, ie the pointer is always updated. This happens even if the ++ field is cleared. Specifically, the increment of the pointer is done in parallel with the testing of R12. **Fix/Workaround**

None.

2. RETE instruction does not clear SREG[L] from interrupts.

The RETE instruction clears SREG[L] as expected from exceptions. $\ensuremath{\textit{Fix/Workaround}}$

When using the STCOND instruction, clear SREG[L] in the stacked value of SR before returning from interrupts with RETE.

3. Exceptions when system stack is protected by MPU

RETS behaves incorrectly when MPU is enabled and MPU is configured so that system stack is not readable in unprivileged mode.

Fix/Woraround

Workaround 1: Make system stack readable in unprivileged mode, or

Workaround 2: Return from supervisor mode using rete instead of rets. This requires :

1. Changing the mode bits from 001b to 110b before issuing the instruction. Updating the mode bits to the desired value must be done using a single mtsr instruction so it is done atomically. Even if this step is described in general as not safe in the UC technical reference guide, it is safe in this very specific case.

2. Execute the RETE instruction.



15.3 Rev. I

15.3.1 PWM

1. PWM channel interrupt enabling triggers an interrupt

When enabling a PWM channel that is configured with center aligned period (CALG=1), an interrupt is signalled.

Fix/Workaround

When using center aligned mode, enable the channel and read the status before channel interrupt is enabled.

2. PWM counter restarts at 0x0001

The PWM counter restarts at 0x0001 and not 0x0000 as specified. Because of this the first PWM period has one more clock cycle.

Fix/Workaround

- The first period is 0x0000, 0x0001, ..., period
- Consecutive periods are 0x0001, 0x0002, ..., period

3. PWM update period to a 0 value does not work

It is impossible to update a period equal to 0 by the using the PWM update register (PWM_CUPD).

Fix/Workaround

Do not update the PWM_CUPD register with a value equal to 0.

15.3.2 ADC

1. Sleep Mode activation needs additional A to D conversion

If the ADC sleep mode is activated when the ADC is idle the ADC will not enter sleep mode before after the next AD conversion.

Fix/Workaround

Activate the sleep mode in the mode register and then perform an AD conversion.

15.3.3 SPI

1. SPI Slave / PDCA transfer: no TX UNDERRUN flag

There is no TX UNDERRUN flag available, therefore in SPI slave mode, there is no way to be informed of a character lost in transmission.

Fix/Workaround

For PDCA transfer: none.

2. SPI FDIV option does not work

Selecting clock signal using FDIV = 1 does not work as specified.

Fix/Workaround

Do not set FDIV = 1.

3. SPI Bad Serial Clock Generation on 2nd chip_select when SCBR = 1, CPOL=1 and NCPHA=0

When multiple CS are in use, if one of the baudrate equals to 1 and one of the others doesn't equal to 1, and CPOL=1 and CPHA=0, then an aditional pulse will be generated on SCK. **Fix/workaround**



When multiple CS are in use, if one of the baudrate equals 1, the other must also equal 1 if CPOL=1 and CPHA=0.

4. SPI Glitch on RXREADY flag in slave mode when enabling the SPI or during the first transfer

In slave mode, the SPI can generate a false RXREADY signal during enabling of the SPI or during the first transfer.

Fix/Workaround

- 1. Set slave mode, set required CPOL/CPHA.
- 2. Enable SPI.
- 3. Set the polarity CPOL of the line in the opposite value of the required one.
- 4. Set the polarity CPOL to the required one.
- 5. Read the RXHOLDING register.

Transfers can now befin and RXREADY will now behave as expected.

5. SPI Disable does not work in Slave mode Fix/workaround

Read the last received data then perform a Software reset.

15.3.4 Power Manager

1. If the BOD level is higher than VDDCORE, the part is constantly under reset

If the BOD level is set to a value higher than VDDCORE and enabled by fuses, the part will be in constant reset.

Fix/Workaround

Apply an external voltage on VDDCORE that is higher than the BOD level and is lower than VDDCORE max and disable the BOD.

15.3.5 Flashc

1. On AT32UC3A0512 and AT32UC3A1512, corrupted read in flash after FLASHC WP, EP, EA, WUP, EUP commands may happen

- After a FLASHC Write Page (WP) or Erase Page (EP) command applied to a page in a given half of the flash (first or last 256 kB of flash), reading (data read or code fetch) the other half of the flash may fail. This may lead to an exception or to other errors derived from this corrupted read access.

After a FLASHC Erase All (EA) command, reading (data read or code fetch) the flash may fail. This may lead to an exception or to other errors derived from this corrupted read access.
After a FLASHC Write User Page (WUP) or Erase User Page (EUP) command, reading (data read or code fetch) the second half (last 256 kB) of the flash may fail. This may lead to an exception or to other errors derived from this corrupted read access.

Fix/Workaround

Flashc WP, EP, EA, WUP, EUP commands: these commands must be issued from RAM or through the EBI. After these commands, read twice one flash page initialized to 00h in each half part of the flash.

15.3.6 PDCA

1. Wrong PDCA behavior when using two PDCA channels with the same PID.



15.3.7	GPIO		Workaround/fix The same PID should not be assigned to more than one channel.
		1.	Some GPIO VIH (input high voltage) are 3.6V max instead of 5V tolerant Only 11 GPIOs remain 5V tolerant (VIHmax=5V):PB01, PB02, PB03, PB10, PB19, PB20, PB21, PB22, PB23, PB27, PB28. Workaround/fix None.
15.3.8	USART		
		1.	ISO7816 info register US_NER cannot be read The NER register always returns zero. Fix/Workaround None.
15.3.9	тwi		
		1.	The TWI RXRDY flag in SR register is not reset when a software reset is performed. Fix/Workaround
15.3.10	SDRAMC		After a Software Reset, the register TWI RHR must be read.
		1.	Code execution from external SDRAM does not work Code execution from SDRAM does not work.
15.3.11	Processor and	d Ar	Fix/Workaround Do not run code from SDRAM. chitecture
		1.	LDM instruction with PC in the register list and without ++ increments Rp For LDM with PC in the register list: the instruction behaves as if the ++ field is always set, ie the pointer is always updated. This happens even if the ++ field is cleared. Specifically, the increment of the pointer is done in parallel with the testing of R12. Fix/Workaround None.
		2.	RETE instruction does not clear SREG[L] from interrupts. The RETE instruction clears SREG[L] as expected from exceptions. Fix/Workaround When using the STCOND instruction, clear SREG[L] in the stacked value of SR before
			returning from interrupts with RETE.
		3.	Exceptions when system stack is protected by MPU RETS behaves incorrectly when MPU is enabled and MPU is configured so that system stack is not readable in unprivileged mode. Fix/Woraround Workaround 1: Make system stack readable in unprivileged mode,
			or Workaround 2: Return from supervisor mode using rete instead of rets. This requires : 1. Changing the mode bits from 001b to 110b before issuing the instruction.

Updating the mode bits to the desired value must be done using a single mtsr instruction so it is done atomically. Even if this step is described in general as not safe in the UC technical reference guide, it is safe in this very



specific case. 2. Execute the RETE instruction.



15.4 Rev. H

15.4.1 PWM

1. PWM channel interrupt enabling triggers an interrupt

When enabling a PWM channel that is configured with center aligned period (CALG=1), an interrupt is signalled.

Fix/Workaround

When using center aligned mode, enable the channel and read the status before channel interrupt is enabled.

2. PWM counter restarts at 0x0001

The PWM counter restarts at 0x0001 and not 0x0000 as specified. Because of this the first PWM period has one more clock cycle.

Fix/Workaround

- The first period is 0x0000, 0x0001, ..., period
- Consecutive periods are 0x0001, 0x0002, ..., period

3. PWM update period to a 0 value does not work

It is impossible to update a period equal to 0 by the using the PWM update register (PWM_CUPD).

Fix/Workaround

Do not update the PWM_CUPD register with a value equal to 0.

15.4.2 ADC

1. Sleep Mode activation needs additional A to D conversion

If the ADC sleep mode is activated when the ADC is idle the ADC will not enter sleep mode before after the next AD conversion.

Fix/Workaround

Activate the sleep mode in the mode register and then perform an AD conversion.

15.4.3 SPI

1. SPI Slave / PDCA transfer: no TX UNDERRUN flag

There is no TX UNDERRUN flag available, therefore in SPI slave mode, there is no way to be informed of a character lost in transmission.

Fix/Workaround

For PDCA transfer: none.

2. SPI FDIV option does not work

Selecting clock signal using FDIV = 1 does not work as specified.

Fix/Workaround

Do not set FDIV = 1

3. SPI disable does not work in SLAVE mode. Fix/Workaround

Read the last received data, then perform a Software Reset.



4. SPI Bad Serial Clock Generation on 2nd chip_select when SCBR = 1, CPOL=1 and NCPHA=0

When multiple CS are in use, if one of the baudrate equals to 1 and one of the others doesn't equal to 1, and CPOL=1 and CPHA=0, then an aditional pulse will be generated on SCK. **Fix/workaround**

When multiple CS are in use, if one of the baudrate equals 1, the other must also equal 1 if CPOL=1 and CPHA=0.

5. SPI Glitch on RXREADY flag in slave mode when enabling the SPI or during the first transfer

In slave mode, the SPI can generate a false RXREADY signal during enabling of the SPI or during the first transfer.

Fix/Workaround

1. Set slave mode, set required CPOL/CPHA.

- 2. Enable SPI.
- 3. Set the polarity CPOL of the line in the opposite value of the required one.
- 4. Set the polarity CPOL to the required one.
- 5. Read the RXHOLDING register.

Transfers can now befin and RXREADY will now behave as expected.

6. SPI Disable does not work in Slave mode Fix/workaround

Read the last received data then perform a Software reset.

15.4.4 Power Manager

1. Wrong reset causes when BOD is activated

Setting the BOD enable fuse will cause the Reset Cause Register to list BOD reset as the reset source even though the part was reset by another source.

Fix/Workaround

Do not set the BOD enable fuse, but activate the BOD as soon as your program starts.

2. If the BOD level is higher than VDDCORE, the part is constantly under reset

If the BOD level is set to a value higher than VDDCORE and enabled by fuses, the part will be in constant reset.

Fix/Workaround

Apply an external voltage on VDDCORE that is higher than the BOD level and is lower than VDDCORE max and disable the BOD.

15.4.5 FLASHC

1. On AT32UC3A0512 and AT32UC3A1512, corrupted read in flash after FLASHC WP, EP, EA, WUP, EUP commands may happen

- After a FLASHC Write Page (WP) or Erase Page (EP) command applied to a page in a given half of the flash (first or last 256 kB of flash), reading (data read or code fetch) the other half of the flash may fail. This may lead to an exception or to other errors derived from this corrupted read access.

After a FLASHC Erase All (EA) command, reading (data read or code fetch) the flash may fail. This may lead to an exception or to other errors derived from this corrupted read access.
After a FLASHC Write User Page (WUP) or Erase User Page (EUP) command, reading



		(data read or code fetch) the second half (last 256 kB) of the flash may fail. This may lead to an exception or to other errors derived from this corrupted read access.
		Fix/Workaround Flashc WP, EP, EA, WUP, EUP commands: these commands must be issued from RAM or through the EBI. After these commands, read twice one flash page initialized to 00h in each half part of the flash.
15.4.6	PDCA	
15.4.7	тwi	 Wrong PDCA behavior when using two PDCA channels with the same PID. Workaround/fix The same PID should not be assigned to more than one channel.
15.4.8	SDRAMC	 The TWI RXRDY flag in SR register is not reset when a software reset is performed. Fix/Workaround After a Software Reset, the register TWI RHR must be read.
13.4.0	SDRAMC	
		1. Code execution from external SDRAM does not work Code execution from SDRAM does not work.
15.4.9	GPIO	Fix/Workaround Do not run code from SDRAM.
		 Some GPIO VIH (input high voltage) are 3.6V max instead of 5V tolerant Only 11 GPIOs remain 5V tolerant (VIHmax=5V):PB01, PB02, PB03, PB10, PB19, PB20, PB21, PB22, PB23, PB27, PB28. Workaround/fix None.
15.4.10	USART	None.
		 ISO7816 info register US_NER cannot be read The NER register always returns zero. Fix/Workaround None.
15.4.11	Processor and	d Architecture
		 LDM instruction with PC in the register list and without ++ increments Rp For LDM with PC in the register list: the instruction behaves as if the ++ field is always set, ie the pointer is always updated. This happens even if the ++ field is cleared. Specifically, the increment of the pointer is done in parallel with the testing of R12. Fix/Workaround None.
		 RETE instruction does not clear SREG[L] from interrupts. The RETE instruction clears SREG[L] as expected from exceptions. Fix/Workaround

When using the STCOND instruction, clear SREG[L] in the stacked value of SR before returning from interrupts with RETE.

3. Exceptions when system stack is protected by MPU



RETS behaves incorrectly when MPU is enabled and MPU is configured so that system stack is not readable in unprivileged mode.

Fix/Woraround

Workaround 1: Make system stack readable in unprivileged mode, or

Workaround 2: Return from supervisor mode using rete instead of rets. This requires :

1. Changing the mode bits from 001b to 110b before issuing the instruction. Updating the mode bits to the desired value must be done using a single mtsr instruction so it is done atomically. Even if this step is described in general as not safe in the UC technical reference guide, it is safe in this very specific case.

2. Execute the RETE instruction.



15.5 Rev. E

15.5.1 SPI

1. SPI FDIV option does not work

Selecting clock signal using FDIV = 1 does not work as specified.

Fix/Workaround

Do not set FDIV = 1.

2. SPI Slave / PDCA transfer: no TX UNDERRUN flag

There is no TX UNDERRUN flag available, therefore in SPI slave mode, there is no way to be informed of a character lost in transmission.

Fix/Workaround

For PDCA transfer: none.

3. SPI Bad serial clock generation on 2nd chip select when SCBR=1, CPOL=1 and CNCPHA=0

When multiple CS are in use, if one of the baudrate equals to 1 and one of the others doesn't equal to 1, and CPOL=1 and CPHA=0, then an additional pulse will be generated on SCK.

Fix/Workaround

When multiple CS are in use, if one of the baudrate equals to 1, the other must also equal 1 if CPOL=1 and CPHA=0.

4. SPI Glitch on RXREADY flag in slave mode when enabling the SPI or during the first transfer

In slave mode, the SPI can generate a false RXREADY signal during enabling of the SPI or during the first transfer.

Fix/Workaround

- 1. Set slave mode, set required CPOL/CPHA.
- 2. Enable SPI.
- 3. Set the polarity CPOL of the line in the opposite value of the required one.
- 4. Set the polarity CPOL to the required one.
- 5. Read the RXHOLDING register.

Transfers can now befin and RXREADY will now behave as expected.

5. SPI CSNAAT bit 2 in register CSR0...CSR3 is not available. Fix/Workaround

Do not use this bit.

6. SPI disable does not work in SLAVE mode. Fix/Workaround

Read the last received data, then perform a Software Reset.

7. SPI Bad Serial Clock Generation on 2nd chip_select when SCBR = 1, CPOL=1 and NCPHA=0

When multiple CS are in use, if one of the baudrate equals to 1 and one of the others doesn't equal to 1, and CPOL=1 and CPHA=0, then an aditional pulse will be generated on SCK.



Fix/workaround

When multiple CS are in use, if one of the baudrate equals 1, the other must also equal 1 if CPOL=1 and CPHA=0.

15.5.2 PWM

1. PWM counter restarts at 0x0001

The PWM counter restarts at 0x0001 and not 0x0000 as specified. Because of this the first PWM period has one more clock cycle.

Fix/Workaround

- The first period is 0x0000, 0x0001, ..., period

- Consecutive periods are 0x0001, 0x0002, ..., period

2. PWM channel interrupt enabling triggers an interrupt

When enabling a PWM channel that is configured with center aligned period (CALG=1), an interrupt is signalled.

Fix/Workaround

When using center aligned mode, enable the channel and read the status before channel interrupt is enabled.

3. PWM update period to a 0 value does not work

It is impossible to update a period equal to 0 by the using the PWM update register (PWM_CUPD).

Fix/Workaround

Do not update the PWM_CUPD register with a value equal to 0.

4. PWM channel status may be wrong if disabled before a period has elapsed

Before a PWM period has elapsed, the read channel status may be wrong. The CHIDx-bit for a PWM channel in the PWM Enable Register will read '1' for one full PWM period even if the channel was disabled before the period elapsed. It will then read '0' as expected.

Fix/Workaround

Reading the PWM channel status of a disabled channel is only correct after a PWM period has elapsed.

15.5.3 SSC

1. SSC does not trigger RF when data is low

The SSC cannot transmit or receive data when CKS = CKDIV and CKO = none, in TCMR or RCMR respectively.

Fix/Workaround

Set CKO to a value that is not "none" and bypass the output of the TK/RK pin with the PIO.

2. SSC Data is not sent unless clock is set as output

The SSC cannot transmit or receive data when CKS = CKDIV and CKO = none, in TCMR or RCMR respectively.

Fix/Workaround

Set CKO to a value that is not "none" and bypass the output of the TK/RK pin with the PIO.



15.5.4 USB

1. USB No end of host reset signaled upon disconnection

In host mode, in case of an unexpected device disconnection whereas a usb reset is being sent by the usb controller, the UHCON.RESET bit may not been cleared by the hardware at the end of the reset.

Fix/Workaround

A software workaround consists in testing (by polling or interrupt) the disconnection (UHINT.DDISCI == 1) while waiting for the end of reset (UHCON.RESET == 0) to avoid being stuck.

2. USBFSM and UHADDR1/2/3 registers are not available.

Do not use USBFSM register.

Fix/Workaround

Do not use USBFSM register and use HCON[6:0] field instead for all the pipes.

15.5.5 Processor and Architecture

1. Incorrect Processor ID

The processor ID reads 0x01 and not 0x02 as it should.

Fix/Workaround

None.

2. Bus error should be masked in Debug mode

If a bus error occurs during debug mode, the processor will not respond to debug commands through the DINST register.

Fix/Workaround

A reset of the device will make the CPU respond to debug commands again.

3. Read Modify Write (RMW) instructions on data outside the internal RAM does not work.

Read Modify Write (RMW) instructions on data outside the internal RAM does not work.

Fix/Workaround

Do not perform RMW instructions on data outside the internal RAM.

4. CRC calculation of a locked device will calculate CRC for 512 kB of flash memory, even though the part has less flash. Fix/Workaround

The flash address space is wrapping, so it is possible to use the CRC value by calculating CRC of the flash content concatenated with itself N times. Where N is 512 kB/flash size.

5. Need two NOPs instruction after instructions masking interrupts

The instructions following in the pipeline the instruction masking the interrupt through SR may behave abnormally.

Fix/Workaround

Place two NOPs instructions after each SSRF or MTSR instruction setting IxM or GM in SR.



6. CPU Cycle Counter does not reset the COUNT system register on COMPARE match. The device revision E does not reset the COUNT system register on COMPARE match. In this revision, the COUNT register is clocked by the CPU clock, so when the CPU clock stops, so does incrementing of COUNT. Fix/Workaround

None.

7. Memory Protection Unit (MPU) is non functional. Fix/Workaround

Do not use the MPU.

8. The following alternate GPIO function C are not available in revE

MACB-WOL on GPIO9 (PA09), MACB-WOL on GPIO18 (PA18), USB-USB_ID on GPIO21 (PA21), USB-USB_VBOF on GPIO22 (PA22), and all function B and C on GPIO70 to GPIO101 (PX00 to PX39).

Fix/Workaround

Do not use these alternate B and C functions on the listed GPIO pins.

9. Clock connection table on Rev E

Here is the table of Rev E

Source	Name	Connection
Internal	TIMER_CLOCK1	32 KHz Oscillator
	TIMER_CLOCK2	PBA Clock / 4
	TIMER_CLOCK3	PBA Clock / 8
	TIMER_CLOCK4	PBA Clock / 16
	TIMER_CLOCK5	PBA Clock / 32
External	XC0	
	XC1	
	XC2	

Figure 15-1. Timer/Counter clock connections on RevE

10. Local Bus fast GPIO not available in RevE. Fix/Workaround

Do not use on this silicon revision.

11. Spurious interrupt may corrupt core SR mode to exception

If the rules listed in the chapter `Masking interrupt requests in peripheral modules' of the AVR32UC Technical Reference Manual are not followed, a spurious interrupt may occur. An interrupt context will be pushed onto the stack while the core SR mode will indicate an exception. A RETE instruction would then corrupt the stack.

Fix/Workaround

Follow the rules of the AVR32UC Technical Reference Manual. To increase software robustness, if an exception mode is detected at the beginning of an interrupt handler, change the stack interrupt context to an exception context and issue a RETE instruction.



12. CPU cannot operate on a divided slow clock (internal RC oscillator) Fix/Workaround

Do not run the CPU on a divided slow clock.

13. LDM instruction with PC in the register list and without ++ increments Rp

For LDM with PC in the register list: the instruction behaves as if the ++ field is always set, ie the pointer is always updated. This happens even if the ++ field is cleared. Specifically, the increment of the pointer is done in parallel with the testing of R12. **Fix/Workaround**

None.

14. RETE instruction does not clear SREG[L] from interrupts.

The RETE instruction clears SREG[L] as expected from exceptions. **Fix/Workaround**

When using the STCOND instruction, clear SREG[L] in the stacked value of SR before returning from interrupts with RETE.

15. Exceptions when system stack is protected by MPU

RETS behaves incorrectly when MPU is enabled and MPU is configured so that system stack is not readable in unprivileged mode.

Fix/Woraround

Workaround 1: Make system stack readable in unprivileged mode, or

Workaround 2: Return from supervisor mode using rete instead of rets. This requires :

1. Changing the mode bits from 001b to 110b before issuing the instruction. Updating the mode bits to the desired value must be done using a single mtsr instruction so it is done atomically. Even if this step is described in general as not safe in the UC technical reference guide, it is safe in this very specific case.

2. Execute the RETE instruction.

15.5.6 SDRAMC

1. Code execution from external SDRAM does not work

Code execution from SDRAM does not work.

Fix/Workaround

Do not run code from SDRAM.

2. SDRAM SDCKE rise at the same time as SDCK while exiting self-refresh mode SDCKE rise at the same time as SDCK while exiting self-refresh mode.

Fix/Workaround

None.

15.5.7 USART

1. USART Manchester Encoder Not Working Manchester encoding/decoding is not working.

Fix/Workaround

Do not use manchester encoding.



2. USART RXBREAK problem when no timeguard

In asynchronous mode the RXBREAK flag is not correctly handled when the timeguard is 0 and the break character is located just after the stop bit.

Fix/Workaround

If the NBSTOP is 1, timeguard should be different from 0.

3. USART Handshaking: 2 characters sent / CTS rises when TX

If CTS switches from 0 to 1 during the TX of a character, if the Holding register is not empty, the TXHOLDING is also transmitted.

Fix/Workaround

None.

4. USART PDC and TIMEGUARD not supported in MANCHESTER

Manchester encoding/decoding is not working.

Fix/Workaround

Do not use manchester encoding.

5. USART SPI mode is non functional on this revision. Fix/Workaround

Do not use the USART SPI mode.

6. DCD is active High instead of Low.

In modem mode the DCD signal is assumed to be active high by the USART, butshould have been active low. **Fix/Workaround**

Add an external inverter to the DCD line.

 ISO7816 info register US_NER cannot be read The NER register always returns zero.
 Fix/Workaround None.

15.5.8 Power Manager

1. Voltage regulator input and output is connected to VDDIO and VDDCORE inside the device

The voltage regulator input and output is connected to VDDIO and VDDCORE respectively inside the device.

Fix/Workaround

Do not supply VDDCORE externally, as this supply will work in paralell with the regulator.

2. Wrong reset causes when BOD is activated

Setting the BOD enable fuse will cause the Reset Cause Register to list BOD reset as the reset source even though the part was reset by another source.

Fix/Workaround

Do not set the BOD enable fuse, but activate the BOD as soon as your program starts.

3. PLL0/1 Lock control does not work

Lock Control does not work for PLL0 and PLL1.



Fix/Workaround

In PLL0/1 Control register, the bit 7 should be set in order to prevent unexpected behaviour.

4. Peripheral Bus A maximum frequency is 33MHz instead of 66MHz. Fix/Workaround

Do not set PBA frequency higher than 33 MHz.

5. PCx pins go low in stop mode

In sleep mode stop all PCx pins will be controlled by GPIO module instead of oscillators. This can cause drive contention on the XINx in worst case.

Fix/Workaround

Before entering stop mode set all PCx pins to input and GPIO controlled.

6. On some rare parts, the maximum HSB and CPU speed is 50MHz instead of 66MHz. Fix/Workaround

Do not set the HSB/CPU speed higher than 50MHz when the firmware generate exceptions.

7. If the BOD level is higher than VDDCORE, the part is constantly under reset

If the BOD level is set to a value higher than VDDCORE and enabled by fuses, the part will be in constant reset.

Fix/Workaround

Apply an external voltage on VDDCORE that is higher than the BOD level and is lower than VDDCORE max and disable the BOD.

8. System Timer mask (Bit 16) of the PM CPUMASK register is not available. Fix/Workaround

Do not use this bit.

15.5.9 HMatrix

 HMatrix fixed priority arbitration does not work Fixed priority arbitration does not work.

Fix/Workaround

Use Round-Robin arbitration instead.

15.5.10 ADC

 ADC possible miss on DRDY when disabling a channel The ADC does not work properly when more than one channel is enabled.

Fix/Workaround

Do not use the ADC with more than one channel enabled at a time.

2. ADC OVRE flag sometimes not reset on Status Register read The OVRE flag does not clear properly if read simultaneously to an end of conversion.

Fix/Workaround None.

3. Sleep Mode activation needs additional A to D conversion



If the ADC sleep mode is activated when the ADC is idle the ADC will not enter sleep mode before after the next AD conversion.

Fix/Workaround

Activate the sleep mode in the mode register and then perform an AD conversion.

15.5.11 ABDAC

 Audio Bitstream DAC is not functional. Fix/Workaround
 Do not use the ABDAC on revE.

15.5.12 FLASHC

- The address of Flash General Purpose Fuse Register Low (FGPFRLO) is 0xFFFE140C on revE instead of 0xFFFE1410. Fix/Workaround None.
- The command Quick Page Read User Page(QPRUP) is not functional. Fix/Workaround None.
- 3. PAGEN Semantic Field for Program GP Fuse Byte is WriteData[7:0], ByteAddress[1:0] on revision E instead of WriteData[7:0], ByteAddress[2:0]. Fix/Workaround

None.

4. On AT32UC3A0512 and AT32UC3A1512, corrupted read in flash after FLASHC WP, EP, EA, WUP, EUP commands may happen

- After a FLASHC Write Page (WP) or Erase Page (EP) command applied to a page in a given half of the flash (first or last 256 kB of flash), reading (data read or code fetch) the other half of the flash may fail. This may lead to an exception or to other errors derived from this corrupted read access.

After a FLASHC Erase All (EA) command, reading (data read or code fetch) the flash may fail. This may lead to an exception or to other errors derived from this corrupted read access.
After a FLASHC Write User Page (WUP) or Erase User Page (EUP) command, reading (data read or code fetch) the second half (last 256 kB) of the flash may fail. This may lead to an exception or to other errors derived from this corrupted read access.

Fix/Workaround

Flashc WP, EP, EA, WUP, EUP commands: these commands must be issued from RAM or through the EBI. After these commands, read twice one flash page initialized to 00h in each half part of the flash.

15.5.13 RTC

1. Writes to control (CTRL), top (TOP) and value (VAL) in the RTC are discarded if the RTC peripheral bus clock (PBA) is divided by a factor of four or more relative to the HSB clock.

Fix/Workaround

Do not write to the RTC registers using the peripheral bus clock (PBA) divided by a factor of four or more relative to the HSB clock.



15.5.14	OCD	 The RTC CLKEN bit (bit number 16) of CTRL register is not available. Fix/Workaround Do not use the CLKEN bit of the RTC on Rev E.
15.5.15	PDCA	 Stalled memory access instruction writeback fails if followed by a HW breakpoint. Consider the following assembly code sequence: A B If a hardware breakpoint is placed on instruction B, and instruction A is a memory access instruction, register file updates from instruction A can be discarded. Fix/Workaround Do not place hardware breakpoints, use software breakpoints instead. Alternatively, place a hardware breakpoint on the instruction before the memory access instruction and then single step over the memory access instruction.
		 Wrong PDCA behavior when using two PDCA channels with the same PID. Workaround/fix The same PID should not be assigned to more than one should be assigned to more than one should be assigned.
15.5.16	ТШ	The same PID should not be assigned to more than one channel.
		 The TWI RXRDY flag in SR register is not reset when a software reset is performed. Fix/Workaround After a Software Reset, the register TWI RHR must be read.



16. Datasheet Revision History

Please note that the referring page numbers in this section are referred to this document. The referring revision in this section are referring to the document revision.

16.1 Rev. K - 01/12

- 1. Update "Errata" on page 70.
- 2. Update eletrical characteristic in "DC Characteristics" on page 41.
- 3. Remove Preliminary from first page.

16.2 Rev. G - 01/09

- 1. Update "Errata" on page 70.
- 2. Update GPIO eletrical characteristic in "DC Characteristics" on page 41.

16.3 Rev. F - 08/08

- 1. Add revision J to "Errata" on page 70.
- 2. Update DMIPS number in "Features" on page 1.
- 16.4 Rev. E 04/08
- 1. Open Drain Mode removed from "General-Purpose Input/Output Controller (GPIO)" on page 151.

16.5 Rev. D - 04/08

- 1. Updated "Signal Description List" on page 8. Removed RXDN and TXDN from USART section.
- 2. Updated "Errata" on page 70. Rev G replaced by rev H.



16.6 Rev. C - 10/07

- 1. Updated "Signal Description List" on page 8. Removed RXDN and TXDN from USART section.
- 2. Updated "Errata" on page 70. Rev G replaced by rev H.

16.7 Rev. B - 10/07

- 1. Updated "Features" on page 1.
- 2. Update "Blockdiagram" on page 4 with local bus.
- 3. Updated "Peripherals" on page 34 with local bus.
- 4. Add SPI feature in "Universial Synchronous/Asynchronous Receiver/Transmitter (USART)" on page 315.
- 5. Updated "USB On-The-Go Interface (USBB)" on page 517.
- 6. Updated "JTAG and Boundary Scan" on page 750 with programming procedure .
- 7. Add description for silicon Rev G.

16.8 Rev. A - 03/07

1. Initial revision.



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